

STIC Search Report

STIC Database Tracking Number

TO: Cynthia Britt Location: RND 2D29

Art Unit: 2133

Tuesday, May 10, 2005

Case Serial Number: 10/068307

From: Geoffrey St. Leger

Location: EIC 2100 Randolph-4B31 Phone: 23450

geoffrey.stleger@uspto.gov

Search Notes

Dear Examiner Britt,

Attached please find the results of your search request for application 10/068307. I searched Dialog's patent files and technical databases, along with the Internet and West.

Please let me know if you have any questions.

Regards

Geoffrey St. Loger



EIC 2100

Questions about the scope or the results of the search? Contact the EIC searcher or contact:

Anne Hendrickson, EIC 2100 Team Leader 272-3490, RND 4B28

Vo	luntary Results Feedback Form	
>	I am an examiner in Workgroup: Example: 2133	
>	Relevant prior art found, search results used as follows:	
	☐ 102 rejection	
	☐ 103 rejection	
	☐ Cited as being of interest.	
	Helped examiner better understand the invention.	
	☐ Helped examiner better understand the state of the art in their technology.	
	Types of relevant prior art found:	
	☐ Foreign Patent(s)	
•	Non-Patent Literature (journal articles, conference proceedings, new product announcements etc.)	
>	Relevant prior art not found:	
	Results verified the lack of relevant prior art (helped determine patentability).	
	Results were not useful in determining patentability or understanding the invention.	
Cor	mments:	

Drop off or send completed forms to STIC/EIC2100 RND, 4B28



```
(c) 2005 JPO & JAPIO
File 350:Derwent WPIX 1963-2005/UD, UM &UP=200529
         (c) 2005 Thomson Derwent
Set
        Items
                 Description
S1
         4426
                 "TEST" () DATA () IN OR TDI OR SCAN () IN
                 "TEST"()DATA()OUT OR TDO OR SCAN()OUT
S2
          616
S3
                 (INPUT OR NORMAL) () DATA OR DATA() IN
       198375
S4
       119318
                 MULTIPLEX??? OR MULTIPLEX??? OR MUX???
S5
        14271
                 DEMULTIPLEX??? OR DEMULTIPLEX??? OR DMUX??? OR DEMUX???
S6
      1284938
                 SWITCH???
S7
       142293
                 SCAN
S8
        57221
                 CAPTUR???
S9
       449967
                 RESPONSE
S10
        31211
                 "TEST"()(VECTOR? ? OR PATTERN? ? OR BIT? ? OR BYTE? ? OR S-
             EQUENCE? ? OR SERIES OR STRING? ? OR DATA OR INFORMATION OR S-
             IGNAL? ? OR CHARACTER? ? OR INPUT? ?)
S11
          320
                 S1 AND S2
                 S11 AND S4 AND S5
S12
            1
S13
         4606
                 "TEST"()DATA()(IN OR INPUT) OR TDI OR SCAN()IN
                 "TEST"()DATA()(OUT OR OUTPUT) OR TDO OR SCAN()OUT
S14
          739
S15
          370
                 S13 AND S14
                 S15 AND S4 AND S5
S16
            1
           33
                 S15 AND S4
S17
S18
            1
                 S15 AND S5
S19
           38
                 S15 AND S6
                 (S17 OR S19) AND S7
           56
S20
S21
                S20 AND S8:S9
            6
S22
        96730
                 (SECOND? OR 2ND) (3W) (S4 OR S6) OR (S4 OR S6) (3W) (2 OR TWO)
S23
                S20 AND S22
                 PA=TEXI
S24
        15111
                S15 AND S24
S25
            7
S26
           10
                 S24 AND S13:S14 AND S7
S27
           35
                 S24 AND S10 AND (S4:S6)
                 S27 AND S8:S9
S28
           11
                 S26 OR S28
S29
           20
                S10 AND S4 AND S5 AND S7
S30
            4
```

File 347: JAPIO Nov 1976-2005/Jan (Updated 050506)

S31

S32

52

15

S20 NOT S29:S30

S31 AND BOUNDARY

```
(Item 1 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
016753620
             **Image available**
WPI Acc No: 2005-077898/200509
XRPX Acc No: N05-068306
  Digital processors e.g. microprocessor, communication emulating method,
  involves supplying single start bit having digital state followed by
  preset data bits to test
                              data
                                     input port for communication to
boundary- scan architecture
Patent Assignee: TEXAS INSTR INC ( TEXI )
Inventor: SWOBODA G L
Number of Countries: 001 Number of Patents: 001
Patent Family:
Patent No
             Kind
                     Date
                              Applicat No
                                             Kind
                                                    Date
                                                             Week
US 6836757
               B1 20041228 US 99120667
                                                  19990219
                                                            200509 B
                                             P
                              US 2000483321
                                             A
                                                  20000114
Priority Applications (No Type Date): US 99120667 P 19990219; US 2000483321
  A 20000114
Patent Details:
                        Main IPC
                                      Filing Notes
Patent No Kind Lan Pg
US 6836757 B1 10 G06F-009/455 Provisional application US 99120667
Abstract (Basic): US 6836757 B1
        NOVELTY - The method involves supplying a serial signal having
    bits, to a test data input port for communication to boundary-scan architecture. Each bit of the signal has a digital state. A
                      data
    single start bit having another digital state followed by preset data
    bits is supplied to the port for communication to the architecture. The
    start bit is sensed within the architecture and the preset bits are
    stored.
        DETAILED DESCRIPTION - An INDEPENDENT CLAIM is also included for a
    digital electronic module.
        USE - Used for emulating communication between digital processors
    e.q. microprocessor, microcontroller and digital signal processor.
        ADVANTAGE - The method easily emulates communication between the
    processors in real time. The method allows a user to control program
    execution, examine or change system memory and core CPU resources.
        DESCRIPTION OF DRAWING(S) - The drawing shows a block diagram form
    protocol multiplexing hardware.
        Input and output switches (201, 202)
        Serial scan path (204)
        Start bit detector (210)
        Processing core (220)
        pp; 10 DwgNo 8/8
Title Terms: DIGITAL; PROCESSOR; MICROPROCESSOR; COMMUNICATE; EMULATION;
  METHOD; SUPPLY; SINGLE; START; BIT; DIGITAL; STATE; FOLLOW; PRESET; DATA;
  BIT; TEST; DATA; INPUT; PORT; COMMUNICATE; BOUNDARY; SCAN; ARCHITECTURE
Derwent Class: S01; T01
International Patent Class (Main): G06F-009/455
File Segment: EPI
            (Item 2 from file: 350)0
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
015738804
             **Image available**
WPI Acc No: 2003-801005/200375
Related WPI Acc No: 2001-637686; 2002-391761; 2002-478804; 2004-429940
XRPX Acc No: N03-641899
  Integrated circuit has scan distributor circuit connected between one
  bond pad and parallel scan circuit input lines, and scan collector
  circuit connected between scan circuit output lines and another bond
```

```
pad
Patent Assignee: WHETSEL L D (WHET-I); TEXAS INSTR INC ( TEXI )
Inventor: WHETSEL L D
Number of Countries: 001 Number of Patents: 002
Patent Family:
Patent No
              Kind
                     Date
                              Applicat No
                                              Kind
                                                     Date
US 20020196045 A1
                    20021226 US 2001836675
                                              A
                                                    20010416 200375 B
                              US 2001997540
                                               Α
                                                   20011129
                              US 9764145
                                              P
US 6646460
               B2 20031111
                                                   19971103
                                                             200382
                              US 98183885
                                              Α
                                                   19981030
                              US 2001836675
                                              Α
                                                   20010416
                              US 2001997540
                                              A
                                                   20011129
Priority Applications (No Type Date): US 2001836675 A 20010416; US
  2001997540 A 20011129; US 9764145 P 19971103; US 98183885 A 19981030
Patent Details:
                        Main IPC
Patent No Kind Lan Pg
                                      Filing Notes
US 20020196045 A1
                     17 G01R-031/26
                                       Div ex application US 2001836675
                                       Div ex patent US 6362015
                        G01R-031/02
                                       Provisional application US 9764145
US 6646460
              B2
                                      Div ex application US 98183885
                                       Div ex application US 2001836675
                                       Div ex patent US 6242269
                                      Div ex patent US 6362015
Abstract (Basic): US 20020196045 A1
        NOVELTY - A scan distributor circuit (300) has a serial input
    connected to a bond pad (302) and has parallel outputs connected to
    input lines (304) of a parallel scan path circuit (324) which is formed on a substrate and connected to functional circuits. A collector
    circuit (344) has parallel inputs connected to output line (346) of the
     scan path circuit and a serial output connected to another bond pad
        DETAILED DESCRIPTION - An INDEPENDENT CLAIM is also included for
    integrated circuit testing process.
        USE - Integrated circuit having testing circuit with parallel scan
     path, scan distributor/collector circuits.
        ADVANTAGE - Provides a way to amplify test
                                                      data
                                                                input to and
    output from an integrated circuit and to test complex core circuits
    embedded within integrated circuit by reuse of scan
    distributor/collector circuits at a low cost.
        DESCRIPTION OF DRAWING(S) - The figure shows the block diagram of
    parallel scan path test arrangement.
        scan distributor circuit (300)
        bond pads (302,366,370,434)
        input lines of scan path circuit (304,322,372,390)
        parallel scan path circuits (324,342,392,410)
        parallel scan collector circuits (344,412)
        output lines of scan path circuit (346,364,414,432)
        pp; 17 DwgNo 3/12
Title Terms: INTEGRATE; CIRCUIT; SCAN; DISTRIBUTE; CIRCUIT; CONNECT; ONE; BOND; PAD; PARALLEL; SCAN; CIRCUIT; INPUT; LINE; SCAN; COLLECT;
  CIRCUIT; CONNECT; SCAN; CIRCUIT; OUTPUT; LINE; BOND; PAD
Derwent Class: S01; U11
International Patent Class (Main): G01R-031/02; G01R-031/26
File Segment: EPI
             (Item 3 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
015567145
             **Image available**
WPI Acc No: 2003-629302/200360
XRPX Acc No: N03-500915
```

Test access port for testing interconnect circuits, has clock input, data input and output, controller, instruction register, boundary scan register and delay circuit.

Patent Assignee: TEXAS INSTR INC (TEXI) ; WHETSEL L D (WHET-I

Inventor: WHETSEL L D

Number of Countries: 035 Number of Patents: 005

Patent Family:

Patent No Kind Date Applicat No Kind Date A2 20030813 EP 1335210 EP 2003100257 20030207 Α 200360 B CN 1438492 Α 20030827 CN 2003104139 Α 20030211 200375 JP 2003344508 A 20031203 JP 200372799 A 20030210 200381 US 20030229835 A1 20031211 US 2002387043 P 20020610 200382 US 2003364100 Α 20030211

US 2003364100 A 20030211 20030819 KR 20038324 A 20030210 200382

Priority Applications (No Type Date): US 2002387043 P 20020610; US 2002356582 P 20020211; US 2003364100 A 20030211

Patent Details:

KR 2003068052 A

Patent No Kind Lan Pg Main IPC Filing Notes

EP 1335210 A2 E 49 G01R-031/3185

Designated States (Regional): AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IT LI LT LU LV MC MK NL PT RO SE SI SK TR

CN 1438492 A G01R-031/28

JP 2003344508 A 129 G01R-031/28

US 20030229835 A1 G01R-031/28 Provisional application US 2002387043

KR 2003068052 A G01R-031/28

Abstract (Basic): EP 1335210 A2

NOVELTY - The test access port includes a test clock input, a test mode select input, and test data input, and a test data output. There is also a controller connected to the test clock input and the mode select input. An instruction register is connected to the test data input and output. The boundary scan register is connected to functional data signals, the test data input and output, and the mode signal output.

DETAILED DESCRIPTION - The controller is used to provide an Update-DR signal, a clock DR signal, and update-DR signal, and a shift-DR signal. The controller has a control bus input. The instruction register has a control bus output connected to the controller, and has a mode signal output. The boundary scan register receives the Update-DR signal and the Shift-DR signal. The register also has a modified Clock-DR input. A delay circuit is connected to the test clock input, and provides a delayed clock output. Test circuitry is connected to the delayed clock output, the control bus, the Update-DR signal, the clock-DR signal, and the modified clock-DR input, to test the functional signals received by the boundary scan register. The test circuitry may comprise propagation test circuitry to test the propagation of the functional signals received by the boundary scan register. INDEPENDENT CLAIMS are included for a process or performing a test, and for a method of testing an interconnect circuit.

USE - For testing high speed AC and DC interconnect circuits located between integrated circuits.

ADVANTAGE - The apparatus provides for extending the JTAG instruction set and architecture, to provide a solution for testing of high speed integrated circuit to integrated circuit interconnect circuits.

DESCRIPTION OF DRAWING(S) - The figure shows a schematic block diagram illustrating the improvement to the basic JTAG architecture

Boundary scan register (503) TAP controller (601)

Instruction register (602)

Delay (603)

Bus (606)

```
pp; 49 DwgNo 6/30
Title Terms: TEST; ACCESS; PORT; TEST; INTERCONNECT; CIRCUIT; CLOCK; INPUT;
  DATA; INPUT; OUTPUT; CONTROL; INSTRUCTION; REGISTER; BOUNDARY; SCAN;
  REGISTER; DELAY; CIRCUIT
Derwent Class: S01; T01; U11; V04
International Patent Class (Main): G01R-031/28; G01R-031/3185
International Patent Class (Additional): G06F-011/22
File Segment: EPI
            (Item 4 from file: 350)
 29/5/4
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
014853663
             **Image available**
WPI Acc No: 2002-674369/200272
XRPX Acc No: N02-533278
  Integrated NAND and flip-flip circuit for digital signal processor,
  includes pre-NAND scan circuit which produces output signals based on
logical state of scan -enable signals, to NAND gate
Patent Assignee: HILL A M (HILL-I); TEXAS INSTR INC ( TEXI )
Inventor: HILL A M
Number of Countries: 001 Number of Patents: 002
Patent Family:
Patent No
              Kind
                     Date
                              Applicat No
                                             Kind
                                                    Date
                    20020822 US 2000258679 A
US 20020113624 A1
                                                   20001227
                                                             200272 B
                              US 2001998823
                                              Δ
                                                  20011203
US 6492841
               B2
                   20021210
                              US 2000258679
                                              A
                                                   20001227
                                                             200301
                              US 2001998823
                                              A
                                                  20011203
Priority Applications (No Type Date): US 2000258679 P 20001227; US
  2001998823 A 20011203
Patent Details:
                        Main IPC
Patent No Kind Lan Pg
                                      Filing Notes
US 20020113624 A1
                      8 H03K-019/20
                                       Provisional application US 2000258679
                                      Provisional application US 2000258679
US 6492841
              B2
                       H03K-019/00
Abstract (Basic): US 20020113624 A1
        NOVELTY - A pre-NAND scan circuit (50) receives a pair of data
    signals (52,54), a scan - in signal (56) and a scan -enable signal
    (58). The pre-NAND circuit produces a pair of output signals (60,62)
    based on the received signals, such that the logical state of the
    output signals are set depending on the logical state of scan -enable
    signal. A NAND gate (48) receives the output signal from the pre-NAND
    circuit.
        DETAILED DESCRIPTION - An INDEPENDENT CLAIM is included for
    flip-flop circuit.
        USE - Integrated NAND and flip-flop circuit for digital signal
    processors that are used in cell phones, personal digital assistant,
    appliances, etc.
        ADVANTAGE - As the pre-NAND circuit and the NAND gate perform the
    overall function, the number of logic gates required is reduced. Hence
    enhances the performance of the digital signal processors.
        DESCRIPTION OF DRAWING(S) - The figure shows the block diagram of
    integrated NAND and flip-flop circuit.
        NAND gate (48)
        Pre-NAND scan circuit (50)
        Data signals (52,54)
         Scan - in signal (56)
        Scan -enable signal (58)
Output signals (60,62)
        pp; 8 DwgNo 3/5
Title Terms: INTEGRATE; NAND; FLIP; FLIP; CIRCUIT; DIGITAL; SIGNAL;
  PROCESSOR; PRE; NAND; SCAN; CIRCUIT; PRODUCE; OUTPUT; SIGNAL; BASED;
```

LOGIC; STATE; SCAN; ENABLE; SIGNAL; NAND; GATE

Derwent Class: U13; U21; U22

International Patent Class (Main): H03K-019/00; H03K-019/20

File Segment: EPI

29/5/5 (Item 5 from file: 350)

DIALOG(R) File 350: Derwent WPIX

(c) 2005 Thomson Derwent. All rts. reserv.

014649503 **Image available**
WPI Acc No: 2002-470207/200250

Related WPI Acc No: 1999-478614; 2000-374818; 2002-598507; 2005-056377

XRPX Acc No: N02-371134

Integrated memory module has memory circuit having switch and bus holder circuit, is connected to input and output of output buffer at signal path, to detect and resolve voltage contention at the output terminal

Patent Assignee: TEXAS INSTR INC (TEXI)

Inventor: WHETSEL L D

Number of Countries: 001 Number of Patents: 001

Patent Family:

Patent No Date Kind Applicat No Kind Date Week US 6378095 US 99259186 200250 B B1 20020423 A 19990226 US 2000521319 Α 20000309

Priority Applications (No Type Date): US 99259186 A 19990226; US 2000521319 A 20000309

Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

US 6378095 B1 29 G01R-031/28 Cont of application US 99259186 Cont of patent US 6055659

Abstract (Basic): US 6378095 B1

NOVELTY - A memory circuit has a feed back path connected to output and input terminal of an output buffer of a signal path. The memory circuit having a **switch** and a bus holder circuit, is selectively operable to detect and resolve voltage contention at the output terminal.

USE - Integrated memory module,

ADVANTAGE - The output buffer has the ability to establish safe test data at IC outputs when the IC is switched from functional mode to boundary test mode. Quickly resolves voltage contention problems at IC output pins. Maintains stable test data at output pins while data is captured and shifted without using output hold memory.

DESCRIPTION OF DRAWING(S) - The figure shows the functional output memory block diagram.

pp; 29 DwgNo 12B/17

Title Terms: INTEGRATE; MEMORY; MODULE; MEMORY; CIRCUIT; SWITCH; BUS; HOLD; CIRCUIT; CONNECT; INPUT; OUTPUT; OUTPUT; BUFFER; SIGNAL; PATH; DETECT; RESOLUTION; VOLTAGE; CONTENTION; OUTPUT; TERMINAL

Derwent Class: S01; U11; U13; U14

International Patent Class (Main): G01R-031/28

International Patent Class (Additional): H04L-001/22

File Segment: EPI

29/5/6 (Item 6 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent All rts. reserv.

014261465 **Image available**
WPI Acc No: 2002-082163/200211
Related WPI Acc No: 2002-068187

XRPX Acc No: N02-061202 Integrated circuit for boundary scan system, has boundary scan path that includes mixture of serially connected dedicated and shared boundary scan cells Patent Assignee: WHETSEL L D (WHET-I); TEXAS INSTR INC (TEXI) Inventor: WHETSEL L D Number of Countries: 001 Number of Patents: 002 Patent Family: Kind Patent No Date Applicat No Kind Date Week 200211 US 20010025356 A1 20010927 US 2000175181 P 20000110 US 2001758089 Α 20010110 US 2000175181 US 6728915 B2 20040427 Ρ 20000110 200429 US 2001758089 А 20010110 Priority Applications (No Type Date): US 2000175181 P 20000110; US 2001758089 A 20010110 Patent Details: Patent No Kind Lan Pg Main IPC Filing Notes US 20010025356 A1 12 G01R-031/28 Provisional application US 2000175181 G01R-031/28 Provisional application US 2000175181 US 6728915 B2 Abstract (Basic): US 20010025356 A1 NOVELTY - A boundary scan path includes a mixture of serially connected dedicated and shared boundary scan cells. A connection is formed between the test data input (TDI) terminal and boundary scan path input and another connection is formed between test output (TDO) terminal and boundary scan path output.
 DETAILED DESCRIPTION - INDEPENDENT CLAIMS are also included for the following: (a) Boundary scan test mode entering process; (b) Intellectual property core circuit within an integrated circuit; (c) Boundary **scan** system USE - For boundary scan system (claimed).
ADVANTAGE - The dedicated scan cells of the scan path can be scanned without disturbing the functional mode of the circuit. As the shared scan cells use shared memories, the test circuitry overhead is reduced. The floating buses that cause high current situations are avoided. DESCRIPTION OF DRAWING(S) - The figure shows the simplified block diagram of boundary scan path around a master integrated circuit and two slave integrated circuits. data input (TDI) output (TDO) Test data pp; 12 DwgNo 6/9 Title Terms: INTEGRATE; CIRCUIT; BOUNDARY; SCAN; SYSTEM; BOUNDARY; SCAN ; PATH; MIXTURE; SERIAL; CONNECT; DEDICATE; SHARE; BOUNDARY; SCAN ; CELL Derwent Class: S01; U11 International Patent Class (Main): G01R-031/28 File Segment: EPI (Item 7 from file: 350) 29/5/7 DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. 014247487 **Image available** WPI Acc No: 2002-068187/200210 Related WPI Acc No: 2002-082163 XRPX Acc No: N02-050492 Integrated circuit with self boundary scan test function, has boundary scan paths having serially connected dedicated and shared boundary scan cells, connected between test data input and output terminals

Patent Assignee: TEXAS INSTR INC (TEXI) ; WHETSEL L D (WHET-I

```
Inventor: WHETSEL L D
Number of Countries: 028 Number of Patents: 003
Patent Family:
Patent No
              Kind
                    Date
                            Applicat No
                                           Kind
                                                 Date
              A2 20010905
                            EP 2001200044
                                                20010109 200210 B
EP 1130409
                                           Α
                           JP 20012712
JP 2001249168 A
                  20010914
                                            Α
                                                20010110 200210
US 20040187059 A1 20040923
                             US 2000175188
                                            P
                            US 2001758089
                                            Α
                                                20010110
                            US 2004814671
                                                20040330
                                            Δ
Priority Applications (No Type Date): US 2000175188 P 20000110; US
  2001758089 A 20010110; US 2004814671 A 20040330
Patent Details:
Patent No Kind Lan Pg
                        Main IPC
                                    Filing Notes
             A2 E 12 G01R-031/3185
   Designated States (Regional): AL AT BE CH CY DE DK ES FI FR GB GR IE IT
   LI LT LU LV MC MK NL PT RO SE SI TR
                   8 G01R-031/28
JP 2001249168 A
US 20040187059 A1
                       G01R-031/28
                                    Provisional application US 2000175188
                                    Div ex application US 2001758089
                                    Div ex patent US 6728915
Abstract (Basic): EP 1130409 A2
        NOVELTY - Boundary scan paths (608,612) having serially connected
     scan cells (C) and shared boundary scan cells (D) are connected
    between test
                   data input and output terminals ( TDI , TDO ).
    Multiplexers (636,638,640) are provided to selectively contacts
    dedicated or shared boundary scan cells between input and output
    terminals.
        DETAILED DESCRIPTION - An INDEPENDENT CLAIM is also included for a
    process of entering into a boundary scan test mode.
        USE - E.g. memory with self boundary scan test function.
        ADVANTAGE - Secures safe entry into test mode from functional mode,
    as the dedicated scan cells can be accessed independent of the shared
    scan cells. Reduces circuitry overhead as the data scan cells use
    shared memories.
       DESCRIPTION OF DRAWING(S) - The figure shows the block circuit
    diagram of IC.
       Boundary scan paths (608,612)
        Multiplexers (636,638,640)
        Serially connected scan cells (C)
        Shared boundary scan cells (D)
                      input and output terminals (TD1, TDO)
               data
       pp; 12 DwgNo 6/9
Title Terms: INTEGRATE; CIRCUIT; SELF; BOUNDARY; SCAN; TEST; FUNCTION;
  BOUNDARY; SCAN; PATH; SERIAL; CONNECT; DEDICATE; SHARE; BOUNDARY; SCAN
  ; CELL; CONNECT; TEST; DATA; INPUT; OUTPUT; TERMINAL
Derwent Class: S01; Ull
International Patent Class (Main): G01R-031/28; G01R-031/3185
International Patent Class (Additional): G06F-011/22
File Segment: EPI
            (Item 8 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
014139845
            **Image available**
WPI Acc No: 2001-624056/200172
Related WPI Acc No: 1997-558436; 2000-085840; 2002-147116; 2004-674581
XRPX Acc No: N01-464880
  Boundary scan input/output serializer circuit for inputting test
 patterns to and outputting test patterns from circuits during a single
```

data register scan operation

```
Patent Assignee: TEXAS INSTR INC ( TEXI )
Inventor: WHETSEL L D
Number of Countries: 001 Number of Patents: 001
Patent Family:
Patent No
                                                   Date
              Kind
                     Date
                             Applicat No
                                            Kind
                                                            Week
US 6189115
              B1 20010213
                             US 93101503
                                            A
                                                 19930730
                                                           200172 B
                             US 95391291
                                             Α
                                                 19950221
                             US 97885464
                                             A · 19970627
                             US 99430932
                                             Α
                                                 19991101
Priority Applications (No Type Date): US 93101503 A 19930730; US 95391291 A
  19950221; US 97885464 A 19970627; US 99430932 A 19991101
Patent Details:
Patent No Kind Lan Pg
                        Main IPC
                                     Filing Notes
US 6189115
                  41 G06F-011/13
                                     Cont of application US 93101503
              B1
                                     Cont of application US 95391291
                                     Div ex application US 97885464
                                     Cont of patent US 5687312
                                     Div ex patent US 6006343
Abstract (Basic): US 6189115 B1
       NOVELTY - A boundary input/output serializer receives input from a
                input pin (102) and control buses (108,110) and outputs
    control to data registers (DREG 1,2) via a control bus (126) and serial
                            output pin (116) via multiplexers (MUX 1,2).
    data to a test data
    The serializer is selected to transfer data from the input to the
    output and, when the serializer is disabled, a connection is made
    between the input and output, to allow the registers to be accessed
    directly by the test access port (TAP).

USE - Serial testing of electrical circuits via scan access.
        ADVANTAGE - More efficient testing.
        DESCRIPTION OF DRAWING(S) - The drawing is a block diagram of the
    serial scan test architecture according to the invention
                data
                      input and output pins (102,116)
         Test
        Control buses (108,110)
        Data registers (DREG 1,2)
        Test access port (TAP)
       pp; 41 DwgNo 8/29
Title Terms: BOUNDARY; SCAN; INPUT; OUTPUT; CIRCUIT; INPUT; TEST; PATTERN
  ; OUTPUT; TEST; PATTERN; CIRCUIT; SINGLE; DATA; REGISTER; SCAN ; OPERATE
Derwent Class: S01; T01; U11; U21; V04
International Patent Class (Main): G06F-011/13
File Segment: EPI
            (Item 9 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
013202945
            **Image available**
WPI Acc No: 2000-374818/200032
Related WPI Acc No: 1999-478614; 2002-470207; 2002-598507; 2005-056377
XRPX Acc No: N00-281405
 Memory circuitry of boundary scan design based integrated circuit, has
  switch and output buffer connected in series between memory and output
  terminals, and input buffer is connected in parallel to output buffer
Patent Assignee: TEXAS INSTR INC ( TEXI
Inventor: WHETSEL L D
Number of Countries: 001 Number of Patents: 001
Patent Family:
Patent No
              Kind
                   Date
                             Applicat No
                                            Kind
                                                   Date
                                                            Week
                   20000425 US 99259186
                                                 19990226 200032 B
US 6055659
              Α
                                            A
```

Priority Applications (No Type Date): US 99259186 A 19990226

Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes US 6055659 Α 29 G01R-031/28

Abstract (Basic): US 6055659 A

NOVELTY - The buffer circuit comprises a switch and output buffer connected in series in between memory and output terminals of integrated circuit. An input buffer electrically weaker than output buffer is connected in parallel to the input terminal. The input and output buffers constitute a latch circuit.

DETAILED DESCRIPTION - The integrated circuit comprises a functional circuit, an output terminal, a test data path and a memory. The memory is selectively connected to functional circuits and test data path through a test control circuit. The switch in the buffer circuit is a three state buffer switch .

USE - For boundary scan design based integrated circuit used in computer systems.

data at IC output when IC is ADVANTAGE - Establishes safe test switched from functional mode to boundary test mode. Solves voltage output problems at IC output pins due to short circuit between pins, ground or supply voltage. Maintains stable test data at output pins without need for output hold memory, when the data is captured and shifted through shared capture /shift memories.

DESCRIPTION OF DRAWING(S) - The figure shows circuit diagram of boundary scan design for two state output IC.

pp; 29 DwgNo 7/17

Title Terms: MEMORY; CIRCUIT; BOUNDARY; SCAN; DESIGN; BASED; INTEGRATE; CIRCUIT; SWITCH; OUTPUT; BUFFER; CONNECT; SERIES; MEMORY; OUTPUT; TERMINAL; INPUT; BUFFER; CONNECT; PARALLEL; OUTPUT; BUFFER

Derwent Class: S01; U11; U14

International Patent Class (Main): G01R-031/28

File Segment: EPI

(Item 10 from file: 350) 29/5/10 DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv.

Image available 012588623 WPI Acc No: 1999-394730/199933

XRPX Acc No: N99-295052

Integrated testing circuit in integrated circuit (IC) memory device

Patent Assignee: TEXAS INSTR INC (TEXI)

Inventor: DORNEY T D

Number of Countries: 001 Number of Patents: 001

Patent Family: Patent No Kind Date Applicat No Kind Date Week A 19990706 US 9620369 US 5920573 A 19960625 199933 B US 96681190 Α 19960722

Priority Applications (No Type Date): US 9620369 P 19960625; US 96681190 A 19960722

Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

A 23 G11C-029/00 US 5920573 Provisional application US 9620369

Abstract (Basic): US 5920573 A

NOVELTY - Multiplexers (230,232,234,236,238,240), each associated with two different arrays of cells, combine the inputs from the associated cell arrays whose outputs are fed to comparators (242,244,246,250). On reception of test data bits from arrays (32-46) of addressable cells, the potential state on each quadrant common line is changed when any comparison fails.

DETAILED DESCRIPTION - The addressable storage cells are formed into arrays which form quadrants. A test data bit is applied through a pin to the storage cells from a writing circuit. An expected data bit is received by a circuit. The stored test data bit in each of the storage cells is read by a read-out circuit. Based on the potential state on all the four common lines, a transmission circuit transmits the potential states of the read-out data from the storage cells. The comparator circuits are placed in close proximity to multiplier circuits which are placed in close proximity to the storage cells. Separate input/output pins are provided for carrying the input and output data bits. In response to a column address change in a quadrant, a column line circuit establishes a potential state on each quadrant-specific common line. An INDEPENDENT CLAIM is also included for an IC testing method in memory devices.

USE - For use in an IC memory device and in some application specific memory devices where additional control signals may be used.

ADVANTAGE - Single internal read and write line can be used for each quadrant to perform read write operations. The read operation performed by the circuit uses only four quadrant-specific common lines which allow the x4 laser repair test to be implemented. The static pull up transistor is replaced by a dynamic transistor for implementing low voltage in the common line.

DESCRIPTION OF DRAWING(S) - The figure shows a block diagram of one quadrant of the integrated testing circuit.

arrays (32-46)

multiplexers (230, 232, 234, 236, 238, 240)

comparators (242,244,246,250)

pp; 23 DwgNo 5/26

Title Terms: INTEGRATE; TEST; CIRCUIT; INTEGRATE; CIRCUIT; IC; MEMORY;

DEVICE

Derwent Class: S01; U11; U14

International Patent Class (Main): G11C-029/00

File Segment: EPI

29/5/11 (Item 11 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

012081116 **Image available**
WPI Acc No: 1998-498027/199843
Related WPI Acc No: 2004-489902

XRPX Acc No: N98-389046

Probeless testing of integrated circuit on semiconductor wafer - using switches located in test paths between output buffer and tester, and voltmeter to measure output response of buffer

Patent Assignee: TEXAS INSTR INC (TEXI) ; WHETSEL L D (WHET-I

Inventor: WHETSEL L D

Number of Countries: 028 Number of Patents: 010

Patent Family:

Patent No	Kind	Date	Applicat No	Kind	Date	Week	
EP 867727	A2	19980930	EP 98200962	A	19980326	199843	В
JP 11030652	A	19990202	JP 9881972	A	19980327	199915	
KR 98080795	A	19981125	KR 9810773	A	19980327	200005	
US 6199182	B1	20010306	US 9741729	P	19970327	200115	
			US 9849626	A	19980327		
TW 421845	A	20010211	TW 98104590	A	19980407	200146	
US 20010014959) A1	20010816	US 9741729	P	19970327	200149	
			US 9849626	Α	19980327		
		•	US 2000745523	Α	20001221		
US 6731106	B2	20040504	US 9741729	P	19970327	200430	
			US 9849626	A	19980327		
			US 2000745523	A	20001221		
EP 867727	B1	20040602	EP 98200962	Α	19980326	200441	
			EP 2004100986	A	19980326		
DE 69824226	E	20040708	DE 98624226	Α	19980326	200445	
			EP 98200962	Α	19980326		
US 20040181729) A1	20040916	US 9741729	P	19970327	200461	

US 9849626 A 19980327 US 2000745523 A 20001221 US 2004806539 A 20040323

Priority Applications (No Type Date): US 9741729 P 19970327; US 9741619 P
 19970327; US 9741621 P 19970327; US 9849626 A 19980327; US 2000745523 A
 20001221; US 2004806539 A 20040323
Cited Patents: No-SR.Pub
Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes EP 867727 A2 E 41 G01R-031/265

Designated States (Regional): AL AT BE CH DE DK ES FI FR GB GR IE IT LI LT LU LV MC MK NL PT RO SE SI

JP 11030652 A 30 G01R-031/28 KR 98080795 A G01R-031/26

US 6199182 B1 G01R-031/28 Provisional application US 9741729

TW 421845 A H01L-021/66

US 20010014959 A1 G01R-031/28 Provisional application US 9741729

Div ex application US 9849626
Div ex patent US 6199182
US 6731106
B2
G01R-031/28
Provisional application US 9741729
Div ex application US 9849626
Div ex patent US 6199182

EP 867727 B1 E G01R-031/265 Related to application EP 2004100986 Designated States (Regional): DE FR GB IT NL
DE 69824226 E G01R-031/265 Based on patent EP 867727

US 20040181729 A1 G01R-031/28 Provisional application US 9741729

Div ex application US 9849626 Div ex application US 2000745523 Div ex patent US 6199182 Div ex patent US 6731106

Abstract (Basic): EP 867727 A

The method is for testing the output circuitry of an integrated circuit, which includes an output buffer (350) having an input coupled to core functional circuitry and an output coupled to a terminal pad. The method comprises disconnecting the input of the output buffer from the core functional circuitry, and connecting the input and output of the output buffer to a first and a second test terminal, respectively.

A test signal is applied at a first logic level to the first test terminal, for receipt by output buffer, and the drive strength of the output buffer in response to the test signal is measured at the second test terminal. A second test signal at a second logic level is applied to the first test terminal, for receipt by output buffer, and the drive strength of the output buffer in response to the test signal at the second logic level is then measured at the second test terminal. The output buffer output is connected to load test terminal, with load connected prior to applying test signals. Drive strength of the output buffer may be measured by measuring voltage drop across the load to determine drive current from the output buffer.

ADVANTAGE - Eliminates heat build-up after circuit has been tested. Dwg.37/42

Title Terms: TEST; INTEGRATE; CIRCUIT; SEMICONDUCTOR; WAFER; SWITCH; LOCATE; TEST; PATH; OUTPUT; BUFFER; TEST; VOLTMETER; MEASURE; OUTPUT; RESPOND; BUFFER

Derwent Class: S01; T01; U21

International Patent Class (Main): G01R-031/26; G01R-031/26; G01R-031/28;
H01L-021/66

International Patent Class (Additional): G01R-031/3185; G06F-011/00;
G06F-011/267

File Segment: EPI

29/5/12 (Item 12 from file: 350) DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. 011799888 **Image available** WPI Acc No: 1998-216798/199819 Related WPI Acc No: 1998-130116 XRPX Acc No: N98-171420 Self-initialising and correcting shared resource boundary scan with output latching - includes output buffer structure which is responsive to initiation of test mode for latching, at output terminal, functional data from shared capture -shift memory to resolve voltage contention at output terminal Patent Assignee: TEXAS INSTR INC (TEXI) Inventor: WHETSEL L D Number of Countries: 001 Number of Patents: 001 Patent Family: Patent No Kind Date Applicat No Kind Date Week 199819 B US 5732091 Α 19980324 US 94342525 19941121 Α US 96690379 Α 19960730 US 97783185 A 19970115 Priority Applications (No Type Date): US 94342525 A 19941121; US 96690379 A 19960730; US 97783185 A 19970115 Patent Details: Patent No Kind Lan Pg Main IPC Filing Notes US 5732091 15 G01R-031/28 Cont of application US 94342525 Α Cont of application US 96690379 Abstract (Basic): US 5732091 A An output boundary scan cell includes an output buffer structure (51) connected between a shared capture -shift memory (17) and an output terminal. The output buffer structure is responsive to initiation of a test mode of operation for latching at the output terminal functional test data from the shared capture /shift memory, and is operable to resolve voltage contention at the output terminal. data at IC outputs when IC is ADVANTAGE - Establishes safe test switched from functional mode to boundary test mode without first having to scan safe test data in Quickly resolves voltage contention problems at IC output pins due to shorts between pins, ground or supply voltage. Maintains stable test data at output pins while data is captured and shifted through shared capture -shift memories, without having to use output hold memory. Dwg.7/10 Title Terms: SELF; INITIALISE; CORRECT; SHARE; RESOURCE; BOUNDARY; SCAN ; OUTPUT; LATCH; OUTPUT; BUFFER; STRUCTURE; RESPOND; INITIATE; TEST; MODE; LATCH; OUTPUT; TERMINAL; FUNCTION; TEST; DATA; SHARE; CAPTURE; SHIFT; MEMORY; RESOLUTION; VOLTAGE; CONTENTION; OUTPUT; TERMINAL Derwent Class: S01; T01 International Patent Class (Main): G01R-031/28 File Segment: EPI (Item 13 from file: 350) 29/5/13 DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. 011713206 **Image available** WPI Acc No: 1998-130116/199812 Related WPI Acc No: 1998-216798 XRPX Acc No: N98-102760

IC with boundary scan cell memories for testing - includes signal path between functional logic and terminal including buffer with feedback path

connected from buffer output to its input

Patent Assignee: TEXAS INSTR INC (TEXI)

Inventor: WHETSEL L D

Number of Countries: 001 Number of Patents: 001

Patent Family:

Patent No Kind Date Applicat No Kind Date Week
US 5715255 A 19980203 US 94342525 A 19941121 199812 B

US 95431156 A 19950428 US 96769971 A 19961219

Priority Applications (No Type Date): US 95431156 A 19950428; US 94342525 A 19941121; US 96769971 A 19961219

Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

US 5715255 A 30 G06F-011/00 CIP of application US 94342525 Cont of application US 95431156

Abstract (Basic): US 5715255 A

The integrated circuit includes logic performing logic functions of the integrated circuit. An output terminal is accessible externally of the integrated circuit. A signal path connected between the functional logic and the terminal carries signals between them. The signal path includes a buffer having an output connected to one of the terminal and the functional logic. The signal path also includes a memory element including the buffer and a switch connected to an input of the buffer.

The output of the buffer is connected to the output terminal. A feedback path is connected to the buffer output and to a buffer input for carrying feedback signals from the output to the input.

ADVANTAGE - Eliminates need for high-drive buffers between FIMs and FCL. Provides FOM structure which can resolve voltage contention at output pin, reduce signal path delays associated with conventional FIM and FOM structures and their combinations in boundary scan cells. Provides boundary scan operation without speed penalty to function operation. Can establish safe test data at IC outputs when switched from functional to boundary test mode without having to scan safe test data in .

Dwg.8/17

Title Terms: IC; BOUNDARY; SCAN; CELL; MEMORY; TEST; SIGNAL; PATH; FUNCTION; LOGIC; TERMINAL; BUFFER; FEEDBACK; PATH; CONNECT; BUFFER; OUTPUT; INPUT

Index Terms/Additional Words: FUNCTIONAL; INPUT; MEMORY; FUNCTIONAL; CORE;
LOGIC; FUNCTIONAL; OUTPUT; MEMORY

Derwent Class: T01

International Patent Class (Main): G06F-011/00

File Segment: EPI

29/5/14 (Item 14 from file: 350)

DIALOG(R) File 350: Derwent WPIX

(c) 2005 Thomson Derwent. All rts. reserv.

011035973 **Image available**
WPI Acc No: 1997-013897/199702

XRPX Acc No: N97-012069

Boundary scan cell for integrated circuit input and output pin - has transmission gates to switch test voltage to path carrying analog signal with test voltage maintained

Patent Assignee: TEXAS INSTR INC (TEXI)

Inventor: WHETSEL L D

Number of Countries: 007 Number of Patents: 005

Patent Family:

Patent No Kind Date Applicat No Kind Date Week EP 745935 A1 19961204 EP 96303954 19960531 199702 B Α JP 9218249 Α 19970819 JP 96138638 Α 19960531 199743 US 5872908 19990216 US 95454795 19950531 199914

```
US 97784432
                                             Α
                                                 19970116
EP 745935
               B1
                   20031119
                             EP 96303954
                                             Α
                                                 19960531
                                                           200377
DE 69630730
                   20031224
                             DE 630730
                                             Α
                                                 19960531
                                                           200408
                             EP 96303954
                                             Α
                                                 19960531
Priority Applications (No Type Date): US 95454795 A 19950531; US 97784432 A
  19970116
Cited Patents: 4.Jnl.Ref
Patent Details:
Patent No Kind Lan Pg
                         Main IPC
                                     Filing Notes
EP 745935
              A1 E 28 G06F-011/22
   Designated States (Regional): DE FR GB IT NL
JP 9218249
                    22 G01R-031/28
             Α
US 5872908
                       H04B-017/00
              Α
                                     Cont of application US 95454795
                   G06F-011/22
              B1 E
EP 745935
   Designated States (Regional): DE FR GB IT NL
DE 69630730
                       G06F-011/22
              Ε
                                    Based on patent EP 745935
Abstract (Basic): EP 745935 A
        The boundary scan cell logic includes an input multiplexer
    ), a capture /shift memory (MEM1), two transmission gates (TG1,TG2)
    and a latch buffer. The output memory function is realised by the
    combination of the IC output buffer, the latch buffer and the second
    transmission gate. The two transmission gates realise the output memory
    function and this with the IC core logic shares use of the IC output
    buffer.
        A signal path carries an analog signal to which a test voltage is
    applied and is maintained on the signal path independently of the test
    voltage node. In normal operation system data is passed to the output
    buffer via the first gate with the other disabled. In the test mode the
    second gate passes test
                              data from MEM1 to the input of a latchable
    output buffer (40) with the first gate disabled.
        ADVANTAGE - Simplifies testing of IC along with its wiring
    interconnection. Boundary scan cell requires less logic in IC core
    region and uses respective input and output IC buffers as part of input
    and output boundary scan cells. Provides boundary scan cell and output
    buffer combination that can immediately and asynchronously detect and
    correct short circuit conditions on output pins during Extest operation
    or when IC is being powered up in normal mode.
        Dwg.4/22
Title Terms: BOUNDARY; SCAN; CELL; INTEGRATE; CIRCUIT; INPUT; OUTPUT; PIN;
  TRANSMISSION; GATE; SWITCH; TEST; VOLTAGE; PATH; CARRY; ANALOGUE;
  SIGNAL; TEST; VOLTAGE; MAINTAIN
Derwent Class: S01; T01; U11; U13
International Patent Class (Main): G01R-031/28; G06F-011/22; H04B-017/00
International Patent Class (Additional): G01R-031/3167; H01L-021/822;
  H01L-027/04
File Segment: EPI
             (Item 15 from file: 350)
29/5/15
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
010782741
             **Image available**
WPI Acc No: 1996-279694/199629
XRPX Acc No: N96-235170
  Boundary scan-cells at input and output of integrated circuits -
  simplifies testing wiring interconnections by asynchronously
  detecting-correcting output short-circuit conditions when initially
Patent Assignee: TEXAS INSTR INC ( TEXI ) ; WHETSEL L D (WHET-I
Inventor: WHETSEL L D
Number of Countries: 007 Number of Patents: 010
Patent Family:
```

```
Kind
                                             Kind Date
Patent No
                     Date
                              Applicat No
                                                              Week
EP 717287
               A2 19960619
                              EP 95309149
                                             Α
                                                   19951215
                                                             199629 B
JP 8233908
               Α
                    19960913
                              JP 95327653
                                              Α
                                                   19951215
                                                             199647
EP 717287
               A3
                    19961127
                              EP 95309149
                                              Α
                                                   19951215
                                                             199702
US 5701307
                              US 94357476
               Α
                    19971223
                                              Α
                                                   19941216
                                                             199806
                              US 96711137
                                              A
                                                  19960909
US 5847561
               Α
                    19981208
                              US 94358128
                                                  19941216
                                                             199905
                                                  19950731
                              US 95509405
                                              Α
                              US 97839532
                                              Α
                                                  19970414
US 5859860
               Α
                    19990112
                              US 94357476
                                              Α
                                                  19941216
                                                             199910
                              US 96711137
                                              Α
                                                   19960909
                              US 97910536
                                              Α
                                                  19970724
                    20040217
                              US 94357476
US 6694465
               Bl
                                              Α
                                                  19941216
                                                             200413
                              US 96711137
                                              Α
                                                  19960909
                              US 97910536
                                              Α
                                                  19970724
                              US 97949429
                                                  19971014
                                              A
                              US 99154381
                                                   19990916
                                              Α
                              US 2000686709
                                              A
                                                   20001011
US 20040163022 A1
                    20040819
                              US 94357476
                                                   19941216 200455
                                              Α
                              US 96711137
                                              Α
                                                   19960909
                              US 97910536
                                                   19970724
                                              Α
                                                  19971014
                              US 97949429
                                              Α
                              US 98154381
                                              Α
                                                 19980916
                              US 2000686709
                                              Α
                                                 20001011
                              US 2004773784
                                              A
                                                  20040206
EP 717287
               B1 20041013
                              EP 95309149
                                              Α
                                                   19951215
                                                             200467
               E
                   20041118
                              DE 95633640
DE 69533640
                                              Α
                                                   19951215
                                                             200476
                              EP 95309149
                                              Α
                                                   19951215
Priority Applications (No Type Date): US 95509405 A 19950731; US 94357476 A
  19941216; US 94358128 A 19941216; US 96711137 A 19960909; US 97839532 A
  19970414; US 97910536 A 19970724; US 97949429 A 19971014; US 99154381 A
  19990916; US 2000686709 A 20001011; US 98154381 A 19980916; US 2004773784
  A 20040206
Cited Patents: No-SR.Pub; 2.Jnl.Ref; EP 522413; GB 2266965; US 5134314
Patent Details:
Patent No Kind Lan Pg
                        Main IPC
                                      Filing Notes
EP 717287
              A2 E 30 G01R-031/3185
   Designated States (Regional): DE FR GB IT NL
JP 8233908
                    26 G01R-031/28
             Α
EP 717287
              Α3
                        G01R-031/3185
US 5701307
              Α
                    18 G01R-031/28
                                      Cont of application US 94357476
US 5847561
              Α
                       G01R-031/28
                                      CIP of application US 94358128
                                      Cont of application US 95509405
                                      Cont of application US 94357476
Cont of application US 96711137
US 5859860
              Α.
                        G06F-011/00
                                      Cont of patent US 5701307
US 6694465
              B1
                      G01R-031/28
                                      Cont of application US 94357476
                                      Cont of application US 96711137
                                      Cont of application US 97910536
                                      Cont of application US 97949429
                                      Div ex application US 99154381
                                      Cont of patent US 5701307
Cont of patent US 5859860
                                       Cont of application US 94357476
US 20040163022 A1
                         G01R-031/28
                                      Cont of application US 96711137
                                      Cont of application US 97910536
                                      Cont of application US 97949429
                                      Div ex application US 98154381
                                      Div ex application US 2000686709
                                      Cont of patent US 5701307
Cont of patent US 5859860
                                      Div ex patent US 6694465
EP 717287
              B1 E
                        G01R-031/3185
```

Designated States (Regional): DE FR GB IT NL DE 69533640 G01R-031/3185 Based on patent EP 717287 Abstract (Basic): EP 717287 A The method operates an integrated circuit (IC) contg. normal functional and output circuitry for driving signals to the IC output terminals. The output circuits are disconnected from the functional signal , including circuitry for initial powering-up. Then a test scanning test data, is input to the output circuits, and the expected response observed for occurrence at the output terminals. A disable signal opens a switch (TG1) between the functional and output circuitry, and also sets a drive strength level less than the full drive level. Any output terminal voltage contention is resolved, and any short-circuit thereat repaired, before the functional circuitry is re-connected. USE/ADVANTAGE - Integrated circuit boundary scan testing, for allowing power-up and preventing latchable output buffer (40) from short-circuit damage/destruction, with increased scan-cell functionality and reduced logic overhead. Dwg.4/27 Title Terms: BOUNDARY; SCAN; CELL; INPUT; OUTPUT; INTEGRATE; CIRCUIT; SIMPLIFY; TEST; WIRE; INTERCONNECT; ASYNCHRONOUS; DETECT; CORRECT; OUTPUT ; SHORT; CIRCUIT; CONDITION; INITIAL; POWER; UP Derwent Class: S01; U11 International Patent Class (Main): G01R-031/28; G01R-031/3185; G06F-011/00 International Patent Class (Additional): G06F-011/22; G06F-011/267; H01L-021/82 File Segment: EPI (Item 16 from file: 350) 29/5/16 DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. **Image available** 009910251 WPI Acc No: 1994-177957/199422 XRPX Acc No: N94-140169 Comparator circuit for IC testing system - has device tester linked to DUT with data coupled via comparator giving one signal for tester analysis from comparison of four DUT outputs Patent Assignee: TEXAS INSTR INC (TEXI Inventor: HII F; ROUSEY J E; SINGH I Number of Countries: 001 Number of Patents: 003 Patent Family: Patent No Kind Applicat No Kind Date Date Week EP 600655 A2 19940608 EP 93309308 Α 19931123 199422 US 92979994 US 5422892 19950606 19921123 199528 Α Α US 94284911 Α 19940802 EP 600655 EP 93309308 19931123 А3 19961211 199707 Priority Applications (No Type Date): US 92979994 A 19921123; US 94284911 A 19940802 Cited Patents: No-SR.Pub; EP 206486; US 4768194; US 4916700 Patent Details: Patent No Kind Lan Pg Main IPC Filing Notes A2 E 6 G11C-029/00 EP 600655 US 5422892 Α 5 G01R-031/28 Cont of application US 92979994 EP 600655 Α3 G11C-029/00 Abstract (Basic): EP 600655 A

The integrated circuit testing system includes a device tester (30) connected with the device-under-test (DUT)(31) and a comparator circuit (91). The device tester has address and control lines (32-34,36) connected to the DUT. The data line (45) and write enable line (35) pass via the comparator to the DUT.

When supplying write data to the DUT, the comparator has multiple output lines (37-40) to duplicate the tester output. The write enable line operates four switches (80-83) to effect this. When data is received from the DUT, these outputs are compared with each other in the comparator to give one signal for the tester.

ADVANTAGE - Allows tester to use only one transceiver circuit to test multiple memory paths in one DUT.

Dwq.1/1

Title Terms: COMPARATOR; CIRCUIT; IC; TEST; SYSTEM; DEVICE; TEST; LINK; DATA; COUPLE; COMPARATOR; ONE; SIGNAL; TEST; ANALYSE; COMPARE; FOUR; OUTPUT

Derwent Class: U11; U14

International Patent Class (Main): G01R-031/28; G11C-029/00

File Segment: EPI

29/5/17 (Item 17 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

008828611 **Image available**
WPI Acc No: 1991-332628/199145

XRPX Acc No: N91-254936

Power supply for semiconductor test system - supplies programmed test pattern voltages and switches current range resistors without effecting output voltage

Patent Assignee: TEXAS INSTR INC (TEXI)

Inventor: HEATON D A

Number of Countries: 001 Number of Patents: 001

Patent Family:

Patent No Kind Date Applicat No Kind Date Week
US 5059889 A 19911022 US 90490803 A 19900308 199145 B

Priority Applications (No Type Date): US 90490803 A 19900308

Abstract (Basic): US 5059889 A

The device power supply in a semiconductor test system supplies programmed voltages to a semiconductor device under test and for current range switching of a current range impedance without affecting the output voltage of the device power supply. A closed loop voltage feedback circuit maintains at the device under test the programmed voltage. A closed loop current feedback circuit has its input across the current range impedance. The current feedback circuit functions independent of the closed loop voltage feedback circuit. A number of current range switches are connected inside the closed loop voltage feedback circuit. A compensation capacitor has its value programmed to optimise frequency response at the output circuit baseed on the capacitive load at the output.

The device power supply circuit operates in an auto-crossover servo loop, allowing the power supply to be programmed as a voltage source and a current source at the same time. Functions as a voltage source as long as a programmed current limit is not exceeded.

USE/ADVANTAGE - For VSLI test system and parametric measurement unit in semiconductor test equipment. Implements current range switching without effecting output voltage of OPS.

Dwg.1/3

Title Terms: POWER; SUPPLY; SEMICONDUCTOR; TEST; SYSTEM; SUPPLY; PROGRAM; TEST; PATTERN; VOLTAGE; SWITCH; CURRENT; RANGE; RESISTOR; EFFECT; OUTPUT; VOLTAGE

Index Terms/Additional Words: PARAMETER; MEASURE; UNIT

Derwent Class: S01; U11; U24

International Patent Class (Additional): H02M-003/33

File Segment: EPI

```
(Item 18 from file: 350)
 29/5/18
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
008815387
             **Image available**
WPI Acc No: 1991-319400/199144
XRPX Acc No: N91-244846
   Scan path testing for multiple frequency circuits - disabling multiple
  system clocks using controller and using master clock to drive each
Patent Assignee: TEXAS INSTR INC ( TEXI )
Inventor: SRIDHAR T
Number of Countries: 008 Number of Patents: 007
Patent Family:
Patent No
              Kind
                     Date
                             Applicat No
                                            Kind
                                                   Date
EP 454320
              Α
                   19911030 EP 91303174
                                             Α
                                                 19910410 199144 B
CN 1056003
                   19911106 CN 91102504
                                                 19910418
              Α
                                             Α
                                                           199232
                   19941123
                            CN 91102504
                                                 19910418
CN 1026727
              C
                                            Α
                                                           199546
                             EP 91303174
EP 454320
              B1
                   19951213
                                             A 19910410
                                                           199603
DE 69115338
              E
                   19960125
                             DE 615338
                                             A
                                                 19910410
                                                           199609
                             EP 91303174
                                                 19910410
                                             Α
                   19960130
                                                 19900420
US 5488613
                             US 90511677
              Α
                                             Α
                                                           199611
                             US 92988383
                                             Α
                                                 19921208
KR 220001
               B1
                  19990901 KR 916305
                                             Α
                                                 19910419
                                                           200104
Priority Applications (No Type Date): US 90511677 A 19900420; US 92988383 A
  19921208
Cited Patents: EP 108255; EP 108256
Patent Details:
Patent No Kind Lan Pg Main IPC
                                     Filing Notes
EP 454320
   Designated States (Regional): DE FR GB IT NL
CN 1056003
                       G01R-031/28
             Α
CN 1026727
             C
                       G01R-031/28
             B1 E
                     9 G06F-011/26
EP 454320
   Designated States (Regional): DE FR GB IT NL
DE 69115338
             Ε
                       G06F-011/26
                                     Based on patent EP 454320
US 5488613
                     5 G01R-031/28
                                     Cont of application US 90511677
              Α
KR 220001
              B1
                       G01R-031/28
Abstract (Basic): EP 454320 A
        The method involves using a circuit (8) which contains three
    circuit modules (10a-c). Each module is controlled by its own clock
    (CKLK1, CLK2, CLK3) during normal operation of the circuit. The modules
    communicate over connections (12a,12b),. Multiplexers (14a-c) connect
    either these clocks or a master clock (MCLK) to the circuits as defined
    by a signal from the test system. A test data controller (16) is
    connected to the scan path through the modules. During testing, test
    data is shifted into ( TDI ) the modules and the module output is
    collected ( TDO ) for checking.
         USE/ADVANTAGE - Avoids partitioning problems and delays in such
    circuits.
        Dwg.2/2
Title Terms: SCAN; PATH; TEST; MULTIPLE; FREQUENCY; CIRCUIT; DISABLE;
  MULTIPLE; SYSTEM; CLOCK; CONTROL; MASTER; CLOCK; DRIVE; MODULE
Derwent Class: S01; U11; U13
International Patent Class (Main): G01R-031/28; G06F-011/26
International Patent Class (Additional): G01R-031/28; AFG0-6F011/26
File Segment: EPI
             (Item 19 from file: 350)
 29/5/19
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
008490872
             **Image available**
```

```
WPI Acc No: 1990-377872/199051
XRPX Acc No: N90-287989
  Line interface circuit facilitating testing - generates test signal
  of amplitude not crossing threshold level for allowing to maintain
  connection of input-output units during testing
Patent Assignee: TEXAS INSTR INC ( TEXI ) ; TEXAS INSTR LTD ( TEXI )
Inventor: FATTORI F R; KERSLAKE R M
Number of Countries: 007 Number of Patents: 006
Patent Family:
Patent No
              Kind
                     Date
                              Applicat No
                                             Kind
                                                    Date
                                                             Week
                   19901219 EP 90306136
EP 403147
               Α
                                             Α
                                                  19900606
                                                            199051 B
JP 3129949
                   19910603 JP 8913952
               Α
                                              Α
                                                  19890616
                                                            199128
                   19920707 US 90523784
US 5128962
               Α
                                             A
                                                 19900515
                                                            199230
              A3 19920826 EP 90306136
EP 403147
                                             Α
                                                  19900606
                                                            199337
EP 403147
               B1 19970108 EP 90306136
                                                  19900606
DE 69029606
               \mathbf{E}
                   19970220 DE 629606
                                              Α
                                                  19900606
                                                            199713
                              EP 90306136
                                              Α
                                                  19900606
Priority Applications (No Type Date): GB 8913952 A 19890616
Cited Patents: NoSR.Pub; 3.Jnl.Ref; EP 176646; JP 11026841; JP 60020664; JP
  61231646
Patent Details:
Patent No Kind Lan Pg
                         Main IPC
                                      Filing Notes
             A 9 H04B-003/46
US 5128962
              B1 E 17 H04L-001/24
EP 403147
   Designated States (Regional): DE FR GB IT NL
                        H04L-001/24
DE 69029606
             \mathbf{E}
                                     Based on patent EP 403147
Abstract (Basic): EP 403147 A
        The interface circuit has an output unit for feeding an output
    signal to a first conductor of the line. The output signal has parts
    with a steady level above a threshold range of levels and parts with a
    steady level below the threshold range of levels. An input unit
    receives an input signal from a second conductor of the line, and a
    device selectively applies a signal from the output unit directly to
    the input unit without traversing the line to enable the circuit to be
    tested. The output unit includes a device for selectively producing a
          signal on a steady level of the output signal. The test
    signal is of such limited amplitude that it does not cross the
    threshold level so that during a test it is not necessary to disconnect the output unit from the line. The input unit includes a device
                              signal to provide an indication of the
    responsive to the .test
    functioning of the circuit. The output init includes a clamping device
                                        signal is to be produced to limit
    which is effective when the test
    the voltage so that it does not cross the threshold level.
        ADVANTAGE - Elimination of need for switches between interface
    and line. (10pp Dwg.No.2/5)
Title Terms: LINE; INTERFACE; CIRCUIT; FACILITATE; TEST; GENERATE; TEST;
  SIGNAL; AMPLITUDE; CROSS; THRESHOLD; LEVEL; ALLOW; MAINTAIN; CONNECT;
  INPUT; OUTPUT; UNIT; TEST
Derwent Class: W01; W02
International Patent Class (Main): H04B-003/46; H04L-001/24
International Patent Class (Additional): H04B-017/00; H04L-025/02;
  H04L-029/14
File Segment: EPI
 29/5/20
             (Item 20 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
008115228
             **Image available**
WPI Acc No: 1990-002229/199001
XRPX Acc No: N90-001608
```

Testable digital data storage circuit - has one gate closed and second

and third gates alternately opened during testing and latches async. signals

Patent Assignee: TEXAS INSTR INC (TEXI) ; TEXAS INSTR LTD (TEXI) Inventor: ROBRTSON I C; SIMPSON R D; ROBERTSON I C

Inventor: ROBRISON I C; SIMPSON R D; ROBERTSON I C Number of Countries: 002 Number of Patents: 004

Patent Family:

- ~ .		- , ·						
Pat	ent. No	Kind	Date	Applicat No	Kind	Date	Week	
GB	2220272	. A	19900104	GB 8815417	Α	19880629	199001	В
US	4992727	A	19910212	US 89373123	A	19890628	199109	
US	5122738	A	19920616	US 89373123	A	19890628	199227	
				US 90594517	A	19901009		
GB	2220272	В	19920930	GB 8815417	A	19880629	199240	

Priority Applications (No Type Date): GB 8815417 A 19880629

Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

GB 2220272 · A 13

US 5122738 A 6 G01R-031/28 Div ex application US 89373123

Div ex patent US 4992727

GB 2220272 B 2 G01R-031/28

Abstract (Basic): GB 2220272 A

A testable digital data storage circuit has a gate connected to apply the voltage level established by a switch to the input of a first latch. Two other gates are respectively connected from a test input terminal to the input of the first latch and from the output of the first latch to the input of a second latch. The output of the second latch is connected to a test output terminal.

second latch is connected to a test output terminal.

During normal operation, the first gate is maintained open to pass the voltage level to the first latch. During testing the first gate is closed and the second and third gate are opened alternately.

 $\ensuremath{\text{USE}}$ - Testing circuit in microprocessor and digital signal processor $\ensuremath{\text{mfr}}$.

32/5/1 (Item 1 from file: 347)

DIALOG(R) File 347: JAPIO

(c) 2005 JPO & JAPIO. All rts. reserv.

05278404 **Image available**
BOUNDARY SCANNING CIRCUIT

PUB. NO.: 08-233904 [JP 8233904 A] PUBLISHED: September 13, 1996 (19960913)

INVENTOR(s): ABE YASUYUKI

APPLICANT(s): NEC ENG LTD [329822] (A Japanese Company or Corporation), JP

(Japan)

APPL. NO.: 07-037886 [JP 9537886] FILED: February 27, 1995 (19950227)

INTL CLASS: [6] G01R-031/28; H01L-021/66; H01L-027/04; H01L-021/822

JAPIO CLASS: 46.2 (INSTRUMENTATION -- Testing); 42.2 (ELECTRONICS -- Solid

State Components)

ABSTRACT

PURPOSE: To expedite testing by sequentially wiring the input and output terminals of a plurality of integrated circuits connecting them to starting and finishing ends, controlling a **switching** circuit and a selector, and selecting the wiring.

CONSTITUTION: Serial wirings C1, C2 in which a plurality of input and output terminals I and O of integrated circuits 10a to 10c are sequentially connected are used as output boundary scan buffers. circuits 3a to 3c and selectors 4a, 4c are connected to the starting and finishing ends of the wirings C1, C2. At the time of serial testing, control circuits 50a to 50c control the circuits 3, 4 to select the wirings input to the input terminal TDI of the circuit C2. Test data C1. 10a is output from the output terminal TDO of the circuit 10c via input scan buffers of the circuits 10a to 10c. Thus, as boundary compared with the case that all the input and output terminals are scanned, a test can be executed in about a half as much time.

32/5/2 (Item 2 from file: 347)
DIALOG(R)File 347:JAPIO
(c) 2005 JPO & JAPIO. All rts. reserv.

04977894 **Image available**
INTEGRATED CIRCUIT DEVICE

PUB. NO.: 07-270494 [JP 7270494 A] PUBLISHED: October 20, 1995 (19951020)

INVENTOR(s): NITTA SUSUMU

APPLICANT(s): TOSHIBA CORP [000307] (A Japanese Company or Corporation), JP.

(Japan)

APPL. NO.: 06-060995 [JP 9460995]

FILED: March 30, 1994 (19940330)

INTL CLASS: [6] GO1R-031/28; H01L-021/66

JAPIO CLASS: 46.2 (INSTRUMENTATION -- Testing); 42.2 (ELECTRONICS -- Solid

State Components)

ABSTRACT

PURPOSE: To shorten the testing time and restrain the occurrence of a delay time at the time of normal operation to the minimum by selectively applying one of signals from an internal scan circuit for the first selector means and a test path to the input side of the second selector means.

CONSTITUTION: A scan - in signal TD1 is sent to the input terminal of a boundary scan register 2 as well as to the input terminals A of multiplexers 3-1 to 3-n. Scan - in signals PSI1 to PSIn are sent to the input terminals B of the multiplexers 3-1 to 3-n. In this case, the

multiplexers 3-1 to 3-n select one of respective input signals, depending on a control signal PM and sends the selected signal to scan registers 1-1 to 1-n. Furthermore, a multiplexer 4 selects one of scan - out signals PSO1 to PSOn as output from the registers 1-1 to 1-n, and scan - out signal BSO as output from the register 2, and outputs the selected signal as test data TDO.

32/5/3 (Item 1 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

015282253 **Image available**
WPI Acc No: 2003-343185/200332

XRPX Acc No: N03-274548

Programming apparatus for programmable logic device, has processor and PLD modules connected to central host

Patent Assignee: SIEMENS AG (SIEI)

Inventor: OTTE G

Number of Countries: 025 Number of Patents: 002

Patent Family:

Patent No Kind Date Applicat No Kind Date Week WO 200331997 A2 20030417 WO 2002DE3382 20020911 200332 B Α EP 1432995 A2 20040630 EP 2002774331 Α 20020911 200443 WO 2002DE3382 20020911

Priority Applications (No Type Date): DE 12001047891 A 20010928 Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

WO 200331997 A2 G 11 G01R-031/00

Designated States (National): US

Designated States (Regional): AT BE BG CH CY CZ DE DK EE ES FI FR GB.GR IE IT LU MC NL PT SE SK TR

EP 1432995 A2 G G01R-031/3185 Based on patent WO 200331997 Designated States (Regional): AT BE BG CH CY CZ DE DK EE ES FI FR GB GR IE IT LI LU MC NL PT SE SK TR

Abstract (Basic): WO 200331997 A2

NOVELTY - A boundary scan socket (BSS), a processor (MP) and at least one programmable device (PLD1...PLD4) are connected in a boundary scan chain via boundary scan connectors (TDI, TDO, TMS, TCK). A switch device (SW) is provided so that the processor can be operatively connected as a transmitter and receiver for the boundary scan connections for the programmable devices.

USE - For complex systems such as communication switching system,

USE - For complex systems such as communication **switching** system, in which programmable modules can be re-programmed (updated) via **scan boundary** devices by host.

ADVANTAGE - Eliminates need for local programming.

DESCRIPTION OF DRAWING(S) - The drawing shows an apparatus for testing the functionality of integrated devices in a module.

pp; 11 DwgNo 1/3

Title Terms: PROGRAM; APPARATUS; PROGRAM; LOGIC; DEVICE; PROCESSOR; MODULE; CONNECT; CENTRAL; HOST

Derwent Class: S01; T01; U21

International Patent Class (Main): G01R-031/00; G01R-031/3185

File Segment: EPI

32/5/4 (Item 2 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

015281749 **Image available**
WPI Acc No: 2003-342681/200332
XRPX Acc No: N03-274082

```
Electronic device has test interfaces for multiple subdevices coupled to
                               out of last interface in chain and test
  form chain and test
                         data
         out of scan
data out of scan test interface coupled to bypass multiplexer Patent Assignee: KONINK PHILIPS ELECTRONICS NV (PHIG ); LOUSBERG G E A
  (LOUS-I); VERMEULEN H G H (VERM-I); WAAYERS T F (WAAY-I)
Inventor: LOUSBERG G E A; VERMEULEN H G H; WAAYERS T F
Number of Countries: 034 Number of Patents: 006
Patent Family:
Patent No
                     Date
              Kind
                              Applicat No
                                             Kind
                                                    Date
                                                              Week
WO 200325595
               A2 20030327 WO 2002IB3617
                                              Α
                                                  20020904
                                                             200332 B
US 20030079166 A1 20030424 US 2002245489
                                               Α
                                                   20020917
               A2 20040623 EP 2002762683
EP 1430319
                                              Α
                                                  20020904
                                                             200441
                              WO 2002IB3617
                                                  20020904
                                              Α
KR 2004035848 A
                   20040429
                              KR 2004704092
                                                  20040319
                                              Α
                                                             200456
JP 2005503563 W
                   20050203
                              WO 2002IB3617
                                              Α
                                                  20020904
                                                             200516
                              JP 2003529172
                                              A.
                                                  20020904
                   20041215 CN 2002818281
                                              Α
                                                  20020904
CN ·1555491
               Α
                                                             200519
Priority Applications (No Type Date): EP 2001203565 A 20010920
Patent Details:
Patent No Kind Lan Pg
                         Main IPC
                                      Filing Notes
WO 200325595 A2 E 20 G01R-031/00
   Designated States (National): CN JP KR
   Designated States (Regional): AT BE BG CH CY CZ DE DK EE ES FI FR GB GR
   IE IT LU MC NL PT SE SK TR
                        GO1R-031/28
US 20030079166 A1
EP 1430319
                       G01R-031/3185 Based on patent WO 200325595
              A2 E
   Designated States (Regional): AL AT BE BG CH CY CZ DE DK EE ES FI FR GB
   GR IE IT LI LT LU LV MC MK NL PT RO SE SI SK TR
                       G01R-031/28
KR 2004035848 A
JP 2005503563 W
                    42 G01R-031/28
                                      Based on patent WO 200325595
CN 1555491
                       G01R-031/3185
Abstract (Basic): WO 200325595 A2
        NOVELTY - Electronic device (100) has subdevices (120a, 120b),
    coupled to test interfaces (140a,140b). Test interfaces are arranged in
    chain (140) via test data out (TDO) of first interface (142a) coupled to test data in of next interface (141b). Boundary
    scan test interface (160) for testing other parts of device is coupled
    to start of chain. TDO of last interface (142b) in chain and TDO of
     scan test interface (162) are coupled to bypass multiplexer
        DETAILED DESCRIPTION - By coupling TDO of last interface in chain
    and TDO of scan test interface to bypass multiplexer , two
    possible routes from test
                                  data
                                        input (110) to test
    output (112) are created; through the full chain or through test
    interface only.
        USE - For PCBs carrying multiple subdevices, system-on chip
    architectures, multi-chip modules etc.
        ADVANTAGE - Allows data to be provided to the subdevice test
    interfaces and a further test interface at the same time, thereby
    allowing a subdevice to be debugged while debug data is also provided
    to surrounding logic outwith the subdevice, thus enhancing fault
    coverage. The electronic device can be tested or debugged as a macro
    device or collection of devices.
        DESCRIPTION OF DRAWING(S) - The drawing shows a block diagram of
    the electronic device.
        Electronic device (100)
        Bypass multiplexer (102)
         Test
                data
                       input (110)
                       output
         Test
                data
                               (112)
        Subdevices (120a,120b)
        Chain (140)
        Test interfaces (140a,140b)
                data in of next interface (141b)
         Test
                       out of first interface (142a)
         Test
                data
         Test
                data
                       out of last interface (142b)
```

Boundary scan test interface (160)
Test data out of boundary scan test interface (162)

pp; 20 DwgNo 1/4

Title Terms: ELECTRONIC; DEVICE; TEST; INTERFACE; MULTIPLE; COUPLE; FORM; CHAIN; TEST; DATA; LAST; INTERFACE; CHAIN; TEST; DATA; SCAN; TEST; INTERFACE; COUPLE; MULTIPLEX

Derwent Class: S01; U11; V04

International Patent Class (Main): G01R-031/00; G01R-031/28; G01R-031/3185
File Segment: EPI

32/5/5 (Item 3 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

014433114 **Image available** WPI Acc No: 2002-253817/200230

XRPX Acc No: N02-195923

Programmable boundary scan register for IEEE 1149.1 compliant programmable logic device, has bypass circuit to connect test data input terminal and output terminal of shift register to test data output terminal

Patent Assignee: XILINX INC (XILI-N) Inventor: CURD D R; JACOBSON N G

Number of Countries: 001 Number of Patents: 001

Patent Family:

Patent No Kind Date Applicat No Kind Date Week US 6314539 B1 20011106 US 98176659 A 19981021 200230 B

Priority Applications (No Type Date): US 98176659 A 19981021 Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes US 6314539 B1 24 G01R-031/28

Abstract (Basic): US 6314539 B1

NOVELTY - A bypass circuit has a multiplexer (850) for selectively connecting a test data input terminal and a test data output terminal of a shift register (820) to a test data output terminal.

DETAILED DESCRIPTION - The shift register receives test data signal through the test data input terminal. The bypass circuit selectively connects the test data input terminal and the output terminal of the shift register to the test data output terminal. A parallel latch (830) selectively stores a predetermined test data signal received by the shift register. An output multiplexer (840) has its input terminals connected to the output terminal of the latch and a system data input terminal and its output terminal connected to a system data output terminal. A mode control circuit (860) selectively couples one of mode control signal and disable signal to a select terminal of the output multiplexer.

INDEPENDENT CLAIMS are also included for the following:

- (a) Programmable input-output circuit;
- (b) Programmable logic device.

USE - Programmable boundary scan register (BSR) in programmable input-output circuit of IEEE 1149.1 compliant programmable logic device (PLD) (claimed) including field programmable gate array (FPGA), and complex programmable logic device (CPLD) and other types of integrated circuits (ICs) used in electronic system.

ADVANTAGE - Since the bypass circuit directly passes data signals from the test data input terminals to the test data output terminal, selective removal of BSR cell from the BSR is enabled. Thereby allowing the user to adjust the length and change the configuration of the BSR, and the reduced length BSR facilitates faster boundary scan test procedures.

DESCRIPTION OF DRAWING(S) - The figure shows the block diagram of

```
BSR cell.
        Shift register (820)
Parallel latch (830)
        Output multiplexer
         Multiplexer (850)
        Mode control circuit (860)
        pp; 24 DwgNo 8/12
Title Terms: PROGRAM; BOUNDARY; SCAN; REGISTER; COMPLIANT; PROGRAM;
  LOGIC; DEVICE; CIRCUIT; CONNECT; TEST; DATA; INPUT; TERMINAL; OUTPUT;
  TERMINAL; SHIFT; REGISTER; TEST; DATA; OUTPUT; TERMINAL
Derwent Class: S01; U11
International Patent Class (Main): G01R-031/28
File Segment: EPI
 32/5/6
            (Item 4 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
             **Image available**
012422701
WPI Acc No: 1999-228809/199919
XRPX Acc No: N99-169302
  Standard boundary
                       scan interface extending method of IC
Patent Assignee: BULL HN INFORMATION SYSTEMS INC (HONE )
Inventor: RUSSELL R J
Number of Countries: 001 Number of Patents: 001
Patent Family:
Patent No
              Kind
                     Date
                              Applicat No
                                              Kind
                                                     Date
                                                               Week
US 5887001
               A
                    19990323 US 95572252
                                              Α
                                                   19951213
                                                              199919 B
                              US 97946952
                                                   19971008
                                               Α
Priority Applications (No Type Date): US 95572252 A 19951213; US 97946952 A
Patent Details:
Patent No Kind Lan Pg
                         Main IPC
                                       Filing Notes
US 5887001
                    21 G01R-031/28
                                      Cont of application US 95572252
Abstract (Basic): US 5887001 A
        NOVELTY - An analog control register (122) is operated in response
    to the instructions corresponding to the predetermined data bit pattern
    received through TDI terminal. The analog signal is transferred to
    the IC through TCK and TMS terminal to perform analog testing, based on
    output of register during phase operation determined by a phase control
    counter (153).
        DETAILED DESCRIPTION - A control isolation switch (151) is
    connected between TMS and TCK terminals to input instructions to
    controller for operating the interface in analog and digital modes. The
    phase control counter is connected to the TDI terminal to receive
    external digital control signal, during analog mode and the counter
    outputs predetermined signals that determines predetermined phases of
    operation, based on whether the interface is operated either in analog
    or digital modes. The analog control register is connected to the TDI
    terminal and counter for receiving digital control signal displays
    predetermined phase. The sequencing phase of the IC terminal is
    controlled by connecting a TDI terminal to a TDO terminal through a
     multiplexer (118) based on signal generated by the register. The TMS
    and TCK terminals are connected to respective test and control points
    of IC through corresponding analog switch matrix (134,136). An analog control decoder (124) is connected to the switch matrix through another switch matrix (138). The decoder feeds predetermined data bit
    pattern for operating predetermined switch matrix. A reference
    voltage (140) is applied to the IC through the switch matrix (128),
    when the interface is operated at analog mode.
        An INDEPENDENT CLAIM is included for apparatus for extending the
    capability of standard boundary scan interface of IC.
```

USE - For IC for processing analog and digital signals. ADVANTAGE - Prevents interference by digital circuiting of digital block during analog measurements since control isolation switch is predetermined. Eliminates need to provide separate power since analog switch isolates certain system from other circuits during system power DESCRIPTION OF DRAWING(S) - The figure shows block diagram of digital test system. Multiplexer (118) Analog control register (122) Analog control decoder (124) Switch matrix (128) Analog switch matrix (134,136,138) Reference voltage (140) Control isolation switch (151) Phase control counter (153) pp; 21 DwqNo 1/9 Title Terms: STANDARD; BOUNDARY; SCAN; INTERFACE; EXTEND; METHOD; IC Derwent Class: S01; U11; U13 International Patent Class (Main): G01R-031/28 File Segment: EPI 32/5/7 (Item 5 from file: 350) DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. 012320363 **Image available** WPI Acc No: 1999-126469/199911 XRPX Acc No: N99-092658 scan register for wiring test of LSI board and function test Boundary of semiconductor device mounted on LSI board - has second 'multiplexer which outputs register output signal which is input into output buffer of input-output cell Patent Assignee: KAWASAKI STEEL CORP (KAWI) Number of Countries: 001 Number of Patents: 001 Patent Family: Applicat No Patent No Kind Date Kind Date Week JP 11002664 19990106 JP 97156374 Α 19970613 199911 B A Priority Applications (No Type Date): JP 97156374 A 19970613 Patent Details: Patent No Kind Lan Pg Main IPC Filing Notes 8 G01R-031/28 JP 11002664 A Abstract (Basic): JP 11002664 A NOVELTY - A first multiplexer (12) selectively outputs the signal input to the input terminal of a semiconductor device via the input . buffer (22a) of an input-output (I/O) cell (22), or a scan - in signal. A first flip-flop (14) holds the output of the first multiplexer and outputs a scan - out signal. The output of the first flip-flop is held by a second flip-flop (16). A second multiplexer (18) selectively outputs the signal input into the input terminal of the semiconductor device, or the output signal of the second flip-flop. The output of the second multiplexer is input into the output buffer (22b) of the I/O cell. DETAILED DESCRIPTION - The boundary register (10) is built in each semiconductor device mounted on a LSI board, and is provided corresponding to each input terminal of the semiconductor device. An invertor (20) inverts and outputs the output signal of the second multiplexer . USE - For wiring test of LSI board and function test of semiconductor device mounted on LSI board. ADVANTAGE - Maintains circuit scale of test circuit of boundary scan register even if number of input terminals of semiconductor device increases. Fault detection of boundary scan register can be

performed easily. DESCRIPTION OF DRAWING(S) - The figure shows the circuit diagram of the boundary scan register. (10) boundary scan register; (12) first multiplexer; (14) first flip-flop; (16) second flip-flop; (18) second multiplexer; (20) invertor; (22a) input buffer; (22b) output buffer; (22) input-output cell. Dwg.1/4 Title Terms: BOUNDARY; SCAN; REGISTER; WIRE; TEST; LSI; BOARD; FUNCTION TEST; SEMICONDUCTOR; DEVICE; MOUNT; LSI; BOARD; SECOND; MULTIPLEX; OUTPUT; REGISTER; OUTPUT; SIGNAL; INPUT; OUTPUT; BUFFER; INPUT; OUTPUT; Derwent Class: S01; T01 International Patent Class (Main): G01R-031/28 International Patent Class (Additional): G06F-011/22 File Segment: EPI 32/5/8 (Item 6 from file: 350) DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. **Image available** WPI Acc No: 1999-045995/199904 Related WPI Acc No: 1999-045996; 1999-070854 XRPX Acc No: N99-033497 scan element and communication device - uses input and output terminal side boundary cells connected in parallel between in **and** test data out terminals Patent Assignee: KOKEN KK (KOKE); NAGOYA M (NAGO-I); DUAKISHIZ KK (DUAK-N) Inventor: NAGOYA M Number of Countries: 022 Number of Patents: 011 Patent Family: Patent No Kind Date Applicat No Kind Date Week 19981210 WO 9855926 Α1 WO 98JP2383 19980529 199904 Α EP 987632 A1 20000322 EP 98921883 Α 19980529 200019 WO 98JP2383 Α 19980529 . 20001219 JP 11502040 Х WO 98JP2383 Α 19980529 200104 JP 99502040 19980529 Α 20010226 KR 99710996 Α KR 2001013021 Α 19991126 200154 20010226 KR 2001013200 KR 99711187 Α 19991130 200154 Α KR 2001013201 20010226 KR 99711188 19991130 Α Α 200154 WO 98JP2432 KR 315999 R 20011212 Α 19980602 200247 KR 99711188 19991130 Α KR 316000 В 20011212 WO 98JP2404 Α 19980601 200247 KR 99710996 Α 19991126 WO 98JP2383 US 6658614 B1 20031202 Α 19980529 200379 US 99424454 Α 19991123 CA 2485309 19981210 CA 2291681 Α 19980529 A1 200511 CA 2485309 Α 19980529 KR 454989 В 20041106 WO 98JP2383 Α 19980529 200517 KR 99711187 Α 19991130 Priority Applications (No Type Date): JP 97143804 A 19970602 Patent Details: Patent No Kind Lan Pg Main IPC Filing Notes A1 J 35 G06F-011/22 WO 9855926 Designated States (National): CA JP KR US Designated States (Regional): AT BE CH CY DE DK ES FI FR GB GR IE IT LU MC NL PT SE G06F-011/22 EP 987632 A1 E Based on patent WO 9855926 Designated States (Regional): DE FR GB IT G06F-011/22 JP 11502040 Х Based on patent WO 9855926 KR 2001013021 A G06F-011/22 KR 2001013200 A G01R-031/28

KR 2001013201 A

G06F-011/22

```
Previous Publ. patent KR 2001013201
KR 315999
                         G06F-011/22
                                        Based on patent WO 9855927
                         G06F-011/22
KR 316000
                                        Previous Publ. patent KR 2001013021
               В
                                        Based on patent WO 9858317
Based on patent WO 9855926
US 6658614
               B1
                         G01R-031/28
CA 2485309
               A1 E
                         H04L-012/26
                                        Div ex application CA 2291681
KR 454989
                                        Previous Publ. patent KR 2001013200
               В
                         G01R-031/28
                                        Based on patent WO 9855926
```

Abstract (Basic): WO 9855926 A

The scan element includes a number of input terminal side boundary cells allocated individually to respective input terminals and connected in series. A number of output terminal side boundary cells is allocated individually to respective output terminals and connected in series. A TAP circuit is used for controlling the input of data to the input terminal side boundary cells and the output from the output terminal side boundary cells. A test data in (TDI) terminal is provided for inputting serial data to be fed to the boundary cells. A test data out (TDO) terminal is used for outputting data from the boundary cells as serial data.

A test clock (TCK) terminal is used to which a clock signal is inputted. A test mode select (TMS) terminal is used for inputting a mode signal for switching the operation mode of the TAP circuit. The input and output terminal side boundary cells are connected in parallel between the TDI terminal and the TDO terminal.

Dwg.2/10

Title Terms: BOUNDARY; SCAN; ELEMENT; COMMUNICATE; DEVICE; INPUT; OUTPUT; TERMINAL; SIDE; BOUNDARY; CELL; CONNECT; PARALLEL; TEST; DATA; TEST; DATA; TERMINAL

Derwent Class: S01; T01

International Patent Class (Main): G01R-031/28; G06F-011/22; H04L-012/26

International Patent Class (Additional): G01R-031/28

File Segment: EPI

32/5/9 (Item 7 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

012239886 **Image available** WPI Acc No: 1999-045994/199904

XRPX Acc No: N99-033496

Communication equipment - has communication controller that transmits and receives control data for individually controlling terminals via boundary scanning elements

Patent Assignee: KOKEN KK (KOKE); NAGOYA M (NAGO-I); DUAKISHIZ KK (DUAK-N); DUAXES CORP (DUAX-N)

Inventor: NAGOYA M

Number of Countries: 022 Number of Patents: 007

Patent Family:

racent ramity	•						
Patent No	Kind	Date	Applicat No	Kind	Date	Week	
WO 9855925	A1	19981210	WO 98JP2356	A	19980528	199904	В
EP 987631	A1	20000322	EP 98921861	A	19980528	200019	
			WO 98JP2356	Α	19980528		
JP 11502036	X	20001219	WO 98JP2356	Α	19980528	200104	•
			JP 99502036	A	19980528		
KR 2001013017	A	20010226	KR 99710991	A	19991126	200154	
KR 316001	В.	20011212	WO 98JP2356	A	19980528	200247	
			KR 99710991	A	19991126		
CA 2291692	С	20030520	CA 2291692	A	19980528	200335	
			WO 98JP2356	Α	19980528		
US 6591387	Bl	20030708	WO 98JP2356	A	19980528	200353	
			IIS 99424452	Δ	19991123		

```
Priority Applications (No Type Date): JP 97143809 A 19970602
Patent Details:
Patent No Kind Lan Pg
                          Main IPC
                                      Filing Notes
              A1 J 29 G06F-011/22
WO 9855925
   Designated States (National): CA JP KR US
   Designated States (Regional): AT BE CH CY DE DK ES FI FR GB GR IE IT LU
   MC NL PT SE
EP 987631
               A1 E
                        G06F-011/22
                                      Based on patent WO 9855925
   Designated States (Regional): DE FR GB IT
                        G06F-011/22
                                      Based on patent WO 9855925
JP 11502036 X
KR 2001013017 ·A
                        G06F-011/22
                        G06F-011/22
                                       Previous Publ. patent KR 2001013017
KR 316001
               В
                                      Based on patent WO 9855925
               C E
                                      Based on patent WO 9855925
                        G06F-011/22
CA 2291692
US 6591387
               B1
                        G01R-031/28
                                      Based on patent WO 9855925
Abstract (Basic): WO 9855925 A
         The equipment is composed of a number of boundary cells
    respectively assigned to input terminals and output terminals. A TAP
    circuit controls the data input to and output from the boundary
    cells. a number of boundary scanning elements is provided with test data in (TDI) terminals for inputting serial data to be given to
    the boundary cells. Test data out (TDO) terminals are used
    for outputting the data from the boundary cells as serial data. Test
    clock (TCK) terminals are used for inputting clock signals. Test mode
    select (TMS) terminals are provided for inputting mode signals for
    switching the operational mode of the TAP circuit.
         A number of terminals having ICs which are respectively connected
    to or incorporated with the boundary scanning elements. A communication controller is connected to the boundary scanning
    elements in series and transmits and receives control data for
    individually controlling the terminals through the boundary scanning
    elements. A data communication line is connected to the terminals in
    parallel through which the output data of the terminals are sent to the
    communication controller.
        Dwg.1/9
Title Terms: COMMUNICATE; EQUIPMENT; COMMUNICATE; CONTROL; TRANSMIT;
  RECEIVE; CONTROL; DATA; INDIVIDUAL; CONTROL; TERMINAL; BOUNDARY; SCAN
  ; ELEMENT
Derwent Class: T01
International Patent Class (Main): G01R-031/28; G06F-011/22
International Patent Class (Additional): G06F-011/22
File Segment: EPI
              (Item 8 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
011335447
              **Image available**
WPI Acc No: 1997-313352/199729
XRPX Acc No: N97-259453
  Driver integrated circuit chip for controlling data and signals flowing
  to print-head of non-impact printer - selects test and control data from
                    data output terminal, using registers connected to
  output of test
         data input terminal
Patent Assignee: EASTMAN KODAK CO (EAST ); NEXPRESS SOLUTIONS LLC (NEXP-N)
Inventor: DONAHUE M J; FLEMING P J; FOX T; KELLY E M; MATTERN M W;
  PETRUZELLI C M; FLEMMING P J
Number of Countries: 004 Number of Patents: 005
Patent Family:
Patent No
               Kind
                      Date
                              Applicat No
                                              Kind
                                                     Date
                                                              Week
                    19970702 GB 9626392
                                                   19961219
GB 2308664
               Α
                                              A
                                                             199729 B
               A1 19970703 DE 1054135
DE 19654135
                                              Α
                                                   19961223
                                              A
JP 9207383
               Α
                    19970812 JP 96355519
                                                 19961203 199742
```

```
US 5859657 A 19990112 US 95581025 A 19951228 199910 GB 2308664 B 20001101 GB 9626392 A 19961219 200056
```

Priority Applications (No Type Date): US 95581025 A 19951228 Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

GB 2308664 A 73 G01R-031/28 DE 19654135 A1 38 H04N-001/032 JP 9207383 A 102 B41J-002/44 US 5859657 A B41J-002/47 GB 2308664 B G01R-031/28

Abstract (Basic): GB 2308664 A

The driver IC chip has a driver incorporating current-carrying channels carrying current to respective recording elements on a printhead, and a controller for operating the driver. The controller includes a circuit for providing a test circuit interface having: a test access port for input of update command signals and clock inputs to the test circuit, a test data input terminal for inputting test data and control data into the chip, and registers connected to the test data input terminal for storing control data for operating the driver, and a test data output terminal for outputting test data and control data from the chip to an adjacent chip.

A selector connected to the first registers and the test data output terminal selects test and control data for output from the test data output terminal. The selector includes an instruction register for storing instructions for selecting one of the first registers for receiving data from the test data input terminal and for selecting one of the registers for outputting data from one of the first registers via a multiplexer for controlling the driver.

ADVANTAGE - Enables access to certain registers e.g. LREF and GREF at any time without interrupting normal image data loading and printing operation, and access to additional control functions on driver chips, without need of dedicated secondary data path on driver chip and while still providing standard IEEE 1149.1 testability functions inc. boundary scan . Provides control data for control functions without affecting printing.

Dwg.11/19

Title Terms: DRIVE; INTEGRATE; CIRCUIT; CHIP; CONTROL; DATA; SIGNAL; FLOW; PRINT; HEAD; NON; IMPACT; PRINT; SELECT; TEST; CONTROL; DATA; OUTPUT; TEST; DATA; OUTPUT; TERMINAL; REGISTER; CONNECT; TEST; DATA; INPUT; TERMINAL

Derwent Class: P75; S01; T01; T04; U11; V04

International Patent Class (Main): B41J-002/44; B41J-002/47; G01R-031/28;
H04N-001/032

International Patent Class (Additional): B41J-002/435; B41J-002/45;
B41J-002/455; G06F-011/00; G06F-011/22

File Segment: EPI; EngPI

32/5/11 (Item 9 from file: 350)
DIALOG(R)File 350:Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.

010418860 **Image available**
WPI Acc No: 1995-320175/199541
XRPX Acc No: N95-240871

Integrated circuit test access port - has instruction register coupled to multiplexer and controller with application of first instruction causing multiplexer to select and maintain path between test data input and output lines

Patent Assignee: BULL HN INFORMATION SYSTEMS INC (HONE)

Inventor: RUSSELL R J

Number of Countries: 001 Number of Patents: 001

Patent Family:

Patent No Kind Date Applicat No Kind Date Week
US 5448576 A 19950905 US 92968104 A 19921029 199541 B

Priority Applications (No Type Date): US 92968104 A 19921029

Patent Details:

Patent No Kind Lan Pg Main IPC Filing Notes

US 5448576 A 18 H04B-017/00

Abstract (Basic): US 5448576 A

The port includes a number of register-like transfer circuits, each having an input and an output. The input of each is connected to a test data input line (TDI) and the output to a different, predetermined multiplexer input (0-5). An instruction register (106) stores information pertaining to any one of a number of instructions coded and generating signals defining a number of operational modes.

The instruction register is coupled to the multiplexer (118) and to the controller, and in response to application of a first instruction by the test data input causes the multiplexer to select and during testing maintain the selected as a path between the test data input and output lines (TDO). The transfer circuits effectively provides a minimum length shift path to minimise the number of bits required to be shifted through a string of IC devices to carry out the testing.

ADVANTAGE - Minimises number of bits serially scanned into device controllers by temporarily disabling paths not required. Allows continuous verification of inoperative state of test logic and diagnosis of test logic faults. Decreases amount of external hardware required. Minimises overall boundary scan chain bit length and dependency on clocking for shift operations.

Dwg.1A/6

Title Terms: INTEGRATE; CIRCUIT; TEST; ACCESS; PORT; INSTRUCTION; REGISTER; COUPLE; MULTIPLEX; CONTROL; APPLY; FIRST; INSTRUCTION; CAUSE;

MULTIPLEX; SELECT; MAINTAIN; PATH; TEST; DATA; INPUT; OUTPUT; LINE

Derwent Class: S01; U11; U21

International Patent Class (Main): H04B-017/00

File Segment: EPI

32/5/12 (Item 10 from file: 350)

DIALOG(R) File 350: Derwent WPIX

(c) 2005 Thomson Derwent. All rts. reserv.

010340003 **Image available**
WPI Acc No: 1995-242085/199532

XRPX Acc No: N95-188699

Boundary - Scan -compliant multi-chip module - has number of semiconductor chips in chain each having Test Data Inputs and Test Data Outputs to pass stream of test information bits and has by-pass circuit to be boundary scan compliant

to be boundary scan compliant
Patent Assignee: AT & T CORP (AMTT); AMERICAN TELEPHONE & TELEGRAPH CO
(AMTT); LUCENT TECHNOLOGIES INC (LUCE)

Inventor: JARWALA N T; YAU C W

Number of Countries: 010 Number of Patents: 006

Patent Family:

racent ramity	•						
Patent No	Kind	Date	Applicat No	Kind	Date	Week	
EP 662616	A2	19950712	EP 94309103	A	19941207	199532	В
TW 253031	A	19950801	TW 94109588	A	19941015	199540	
JP 7287053	A	19951031	JP 94336988	A	19941227	199601	
US 5673276	A	19970930	US 93172778	A	19931227	199745	
			US 96716559	A	19960205		
JP 3096597	B2	20001010	JP 94336988	A	19941227	200052	
KR 208306	B1	19990715	KR 9437123	A	19941227	200066	

```
Priority Applications (No Type Date): US 93172778 A 19931227; US 96716559 A
  19960205
Cited Patents: No-SR.Pub
Patent Details:
Patent No Kind Lan Pg
                         Main IPC
                                     Filing Notes
              A2 E 12 G01R-031/28
EP 662616
   Designated States (Regional): DE ES FR GB IT NL
             Α
                       G01R-031/26
JP 7287053
                    12 G01R-031/28
              Α
US 5673276
             Δ
                    11 H04B-017/00
                                     Cont of application US 93172778
JP 3096597
              B2
                    13 G01R-031/28
                                     Previous Publ. patent JP 7287053
KR 208306
             B1
                       G01R-031/28
Abstract (Basic): EP 662616 A
        The module (10) includes a number of semiconductor chips (141-14n)
    with each chip having a Boundary
                                        Scan architecture with a Test
           Input so that the chip can receive a stream of test information
    bits (including instructions and test data). When the stream of test
    information bits have passed through the chip, they appear at it's
    Test Data Output. The chips are coupled in a Boundary - Scan chain so that the initial chip receives signals at its TDI via the
    TDI module.
        The last chip in the chain supplies signals from its TDO to the
        of the module. Each chip in the chain has its TDI coupled to the
    TDO of an upstream chip. A bypass circuit (36') causes the stream of
    test input bits to be bypassed directly from the TDI to the TDO
    during selected intervals so that the chips appear as a single
    Boundary - Scan -compliant device during the interval.
        USE/ADVANTAGE - Multichip module can be tested using Boundary
    Scan test technique. MCM can be tested as circuit board or as single
    device using Boundary scan test technique. Boundary
    circuit enables testing according to IEEE standard 1149.1.
        Dwq.3/10
Title Terms: BOUNDARY; SCAN; COMPLIANT; MULTI; CHIP; MODULE; NUMBER;
  SEMICONDUCTOR; CHIP; CHAIN; TEST; DATA; INPUT; TEST; DATA; OUTPUT; PASS;
  STREAM; TEST; INFORMATION; BIT; BY-PASS; CIRCUIT; BOUNDARY; SCAN;
  COMPLIANT
Derwent Class: S01; T01; U11
International Patent Class (Main): G01R-031/26; G01R-031/28; H04B-017/00
International Patent Class (Additional): G06F-011/22; G06F-011/26;
  H01L-021/66
File Segment: EPI
32/5/13
             (Item 11 from file: 350)
DIALOG(R) File 350: Derwent WPIX
(c) 2005 Thomson Derwent. All rts. reserv.
010245783
            **Image available**
WPI Acc No: 1995-147038/199519
XRPX Acc No: N95-115457
             scan interface extension method for IC - by including
   Boundary
  circuits enabling sharing of data paths at separate time intervals
 defined under instruction control for processing analog and digital
  signals
Patent Assignee: BULL HN INFORMATION SYSTEMS INC (HONE )
Inventor: RUSSELL R J
Number of Countries: 001 Number of Patents: 001
Patent Family:
Patent No
              Kind
                     Date
                             Applicat No
                                            Kind
                                                   Dațe
                                                             Week
US 5404358
              A 19950404 US 9313464
                                             Α
                                                 19930204 199519 B
Priority Applications (No Type Date): US 9313464 A 19930204
Patent Details:
                       Main IPC
Patent No Kind Lan Pg
                                     Filing Notes
```

18 G06F-015/20 US 5404358 Α Abstract (Basic): US 5404358 A The method allows analog and digital signal processing by extending the interface with analog test circuits. The analog test circuits (126,132,128,134,136,138) share the interface data pins. The pins are digital data input (TDI) terminal and digital data output (TDO). They are shared by time allocation. The digital control section (150) generates control signals specifying the mode of operation. It generates enabling signals for connecting TDI and TDO pins. When the digital test circuitry is activated by the interface test clock signal (TCK) the analog test circuits are disabled. The digital test operates until all data are passed. The interface test mode select (TMS) pin and clock (TCK) control the passing of data. Analog data is loaded into the analog control register. It is then loaded into the instruction register. When the instruction is decoded the analog mode is activated. The analog switches in the IC connect the analog measurement circuits of the tester to the TDI , TDO pins for analog measurement. USE/ADVANTAGE - For ICs esp. circuits with standard boundary scan test access port. Provides hybrid capability without increase in interface lines, analog interface without detriment to digital scanning techniques. Dwg.1/7 Title Terms: BOUNDARY; SCAN; INTERFACE; EXTEND; METHOD; IC; CIRCUIT; ENABLE; SHARE; DATA; PATH; SEPARATE; TIME; INTERVAL; DEFINE; INSTRUCTION; CONTROL; PROCESS; ANALOGUE; DIGITAL; SIGNAL Derwent Class: T01; U11 International Patent Class (Main): G06F-015/20 File Segment: EPI 32/5/14 (Item 12 from file: 350) DIALOG(R) File 350: Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. **Image available** 010175329 WPI Acc No: 1995-076582/199511 Related WPI Acc No: 1992-399183 XRPX Acc No: N95-060826 Pin multiplexing for programming and testing IC's - has IC with in system programming and boundary scan testing ability sharing same pins with one dedicated pin to select mode of operation Patent Assignee: LATTICE SEMICONDUCTOR CORP (LATT-N) Inventor: CHAN'A L; SHANKAR K; SHEN J; TSUI C Y Number of Countries: 005 Number of Patents: 005 Patent Family: Patent No Kind Applicat No Date Kind Date EP 639006 A1 19950215 EP 94202212 Α 19940728 199511 B US 5412260 19950502 US 91695356 A Ά 19910503 199523 US 93106263 Α 19930813 JP 7175677 19950714 JP 94211922 19940812 Α Α 199537 EP 94202212 EP 639006 B1 20031022 Α 19940728 200373 DE 633259 DE 69433259 20031127 19940728 200403 E Α EP 94202212 Α 19940728 Priority Applications (No Type Date): US 93106263 A 19930813; US 91695356 A 19910503 Cited Patents: US 5237218; WO 9220157 Patent Details: Patent No Kind Lan Pg Main IPC Filing Notes A1 E 16 H03K-019/173 EP 639006 Designated States (Regional): DE GB IT

13 H03K-019/003 CIP of application US 91695356

CIP of patent US 5237218

US 5412260

Α

14 G06F-011/22 JP 7175677 A B1 E EP 639006 H03K-019/173 Designated States (Regional): DE GB IT H03K-019/173 Based on patent EP 639006 DE 69433259 Ε Abstract (Basic): EP 639006 A The high density programmable logic device includes both boundary scan testing and in-system programming facilities. The device uses five pins to perform either function. One pin (1) is used to select whether programming or testing is to be performed. The other four pins have different uses in each mode. Within the device an input multiplexer (12) decodes the three common input pins (2-4) depending upon the control pin (ISPEN). The output (5) is decoded (14) by another multiplexer. The device has two state machines which control programming (16) or boundary testing (18). ADVANTAGE - Economises on the number of pins required to perform both programming and testing functions. Dwq.4/6 Title Terms: PIN; MULTIPLEX; PROGRAM; TEST; IC; IC; SYSTEM; PROGRAM; BOUNDARY; SCAN; TEST; ABILITY; SHARE; PIN; ONE; DEDICATE; PIN; SELECT; MODE: OPERATE Derwent Class: S01; U11; U13; U21 International Patent Class (Main): G06F-011/22; H03K-019/003; H03K-019/173 International Patent Class (Additional): G01R-031/28 File Segment: EPI 32/5/15 (Item 13 from file: 350) DIALOG(R)File 350:Derwent WPIX (c) 2005 Thomson Derwent. All rts. reserv. 009025786 **Image available** WPI Acc No: 1992-153146/199219 XRPX Acc No: N92-114277 scan test facility - has Integrated circuit with intrinsic boundary all terminals available to series-connected test loop through multiplexers which are themselves monitored Patent Assignee: THOMSON COMPOSANTS (CSFC Inventor: LESTRAT P Number of Countries: 001 Number of Patents: 001 Patent Family: Patent No Kind Date Applicat No Kind Date Week FR 2666902 Α 19920320 FR 9011491 Α 19900918 199219 B Priority Applications (No Type Date): FR 9011491 A 19900918 Patent Details: Main IPC Patent No Kind Lan Pg Filing Notes FR 2666902 20 Α

Abstract (Basic): FR 2666902 A

A boundary scan register links each input (10) with the series-connected test loop(tdi / tdo). One multiplexer (MUX ,16) takes inputs from either side of another (MUX ,18), in the main circuit (10-14), and a third input from the adjoining register(tdi). One of these is selected as output to a time-controlled(H1) flip-flop (20) by centrally provided signals(CTRL1,CTRL1A).

The flip-flop output continues to the following register (tdo), and, through a second time-controlled(H2) flip-flop, provides a second input to the first muiltiplexer (MUX ,18), controlled by another central signal(CTRL2). Output and bi-directional terminals are similarly equipped.

```
8:Ei Compendex(R) 1970-2005/May W1
File
         (c) 2005 Elsevier Eng. Info. Inc.
File
      35:Dissertation Abs Online 1861-2005/Apr
         (c) 2005 ProQuest Info&Learning
File
      65:Inside Conferences 1993-2005/May W2
         (c) 2005 BLDSC all rts. reserv.
File
       2:INSPEC 1969-2005/Apr W4
         (c) 2005 Institution of Electrical Engineers
File
      94:JICST-EPlus 1985-2005/Mar W3
         (c) 2005 Japan Science and Tech Corp(JST)
File
       6:NTIS 1964-2005/May W1
         (c) 2005 NTIS, Intl Cpyrght All Rights Res
File 144: Pascal 1973-2005/May W1
         (c) 2005 INIST/CNRS
File 434:SciSearch(R) Cited Ref Sci 1974-1989/Dec
         (c) 1998 Inst for Sci Info
      34:SciSearch(R) Cited Ref Sci 1990-2005/May W1
         (c) 2005 Inst for Sci Info
      99:Wilson Appl. Sci & Tech Abs 1983-2005/Apr
File
         (c) 2005 The HW Wilson Co.
File 266:FEDRIP 2005/Jan
         Comp & dist by NTIS, Intl Copyright All Rights Res
      95:TEME-Technology & Management 1989-2005/Apr W1
File
         (c) 2005 FIZ TECHNIK
File
      62:SPIN(R) 1975-2005/Feb W4
         (c) 2005 American Institute of Physics
File 239:Mathsci 1940-2005/Jun
         (c) 2005 American Mathematical Society
Set
       .Items
                Description
                "TEST" () DATA () (IN OR INPUT) OR TDI OR SCAN () IN
S1
        13398
                "TEST"()DATA()(OUT OR OUTPUT) OR TDO OR SCAN()OUT
S2
          525
S3
       254777
                 (INPUT OR NORMAL) () DATA OR DATA() IN
                MULTIPLEX??? OR MULTIPLEX??? OR MUX???
S4
       194778
                DEMULTIPLEX??? OR DEMULTIPLEX??? OR DMUX??? OR DEMUX???
S5
        16911
S6
       727048
                SWITCH???
S7
       181054
                SCAN
S8
       380358
                CAPTUR???
      2535760
                RESPONSE
S9
                 (SECOND OR 2ND) (3W) S4:S6 OR S4:S6(2W) (TWO OR 2)
S10
        16316
                S1 AND S2 AND S10 AND S7
S11
S12
            0
                S1:S2 AND S10 AND S7
S13
            0
                S1 AND S2 AND S4 AND S5 AND S7
S14
                S1 AND S2 AND S4 AND S7
            2
                S1:S2 AND S4:S5 AND S7 AND S8:S9
S15
            4
$16
            6
                S14:S15
S17
            3
                RD (unique items)
```

17/5/1 (Item 1 from file: 35)
DIALOG(R)File 35:Dissertation Abs Online
(c) 2005 ProQuest Info&Learning. All rts. reserv.

1060062 ORDER NO: AADDX-84995

AN INVESTIGATION INTO THE REALISATION AND TESTING OF A UNIVERSAL LOGIC PRIMITIVE GATE ARRAY

Author: CHENGJIN, ZHANG

Degree: PH.D. Year: 1988

Corporate Source/Institution: UNIVERSITY OF BATH (UNITED KINGDOM) (0690)

Source: VOLUME 50/02-B OF DISSERTATION ABSTRACTS INTERNATIONAL.

PAGE 639. 382 PAGES

Descriptors: COMPUTER SCIENCE; ENGINEERING, ELECTRONICS AND ELECTRICAL

Descriptor Codes: 0984; 0544

Available from UMI in association with The British Library.

In this thesis, an investigation is described which was carried out into the realisation and testing of a universal logic primitive gate array.

During this study, a new gate array with a more powerful logic primitive, the multiplexer, has been proposed. The CMOS transmission gate has been used to implement this primitive. With it, any logic circuits, including combinational and sequential circuits, can be easily realised. The synthesis can be achieved by either the modular tree structure or unrestricted topologies. Spectral techniques have been used as one of the logic design techniques to improve the design of multiplexer universal logic module circuits.

The placement and routing of this gate array have been considered. For the ease of routing, the linear topology has been adopted, and two terminals to the basic cell have been provided. The comparison between single metal and double metal layers for customisation has been made through the whole design of the layout.

The common faults in digital systems, such as stuck-at faults, bridging faults and CMOS open faults, have been discussed and analysed. Some relationships between stuck-at faults and bridging faults, have been studied and it has been shown that some bridging faults, like input bridging faults and feedback bridging faults, could be detected by stuck-at fault test sets.

The diagnosis of faults in the modular tree structure has been discussed. Providing more test sets, stuck-at faults can be located easily, the detection of stuck-at faults can be done quickly by the test sets formed by two matrices.

The structured design for testing in this gate array has been considered. The partitioning and **scan** in **scan** out design techniques have been used to increase the testability. A proposed built-in test for this gate array has been given.

Throughout the study, all the efforts have been made towards searching for a gate array design which could give a good opportunity for customisation and fault detection in LSI systems.

17/5/2 (Item 1 from file: 2) DIALOG(R)File 2:INSPEC

(c) 2005 Institution of Electrical Engineers. All rts. reserv.

6041721 INSPEC Abstract Number: B9811-1265B-110, C9811-5210B-052
Title: A design-for-testability technique for register-transfer levelcircuits using control/data flow extraction

Author(s): Ghosh, I.; Raghunathan, A.; Jha, N.K.

Author Affiliation: Dept. of Electr. Eng., Princeton Univ., NJ, USA Journal: IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems vol.17, no.8 p.706-23

Publisher: IEEE,

Publication Date: Aug. 1998 Country of Publication: USA

CODEN: ITCSDI ISSN: 0278-0070

SICI: 0278-0070(199808)17:8L.706:DTTR;1-E

Material Identity Number: B959-98014

U.S. Copyright Clearance Center Code: 0278-0070/98/\$10.00

Document Number: S0278-0070(98)05824-2

Language: English Document Type: Journal Paper (JP)
Treatment: Practical (P); Theoretical (T); Experimental (X)

Abstract: In this paper, we present a technique for extracting functional (control/data flow) information from register-transfer controller/data path circuits, and illustrate its use in design for hierarchical testability of these circuits. This scheme does not require any additional behavioral information. It identifies a suitable control and data flow from the register-transfer level circuit, and uses it to test each embedded element in the circuit by symbolically justifying its precomputed test set from the system primary inputs to the element inputs and symbolically propagating the output response to the system primary outputs. When symbolic justification and propagation become difficult, it inserts test multiplexers at suitable points to increase the symbolic controllability and observability of the circuit. These test multiplexers are mostly restricted to off-critical paths. Testability analysis and insertion are completely based on the register-transfer level circuit and the functional information automatically extracted from it, and are independent of the data path bit width owing to their symbolic nature. Furthermore, the data path test set is obtained as a byproduct of this without any further search. Unlike design-for-testability techniques, this scheme makes the combined controller-data path very highly testable. It is general enough to handle control-flow-intensive register-transfer level circuits like protocol handlers as well as data-flow intensive circuits like digital filters. It results in low area/delay/power overheads, high fault coverage, and very low test generation times (because it is symbolic and independent of bit width). Also, a large part of our system-level test sets can be applied at speed. Experimental results on many benchmarks show the average area, delay, and power overheads for testability to be 3.1, 1.0, and 4.2%, respectively. Over 99% fault coverage is obtained in most cases with two-four orders of magnitude test generation time advantage over an efficient gate-level sequential test pattern generator and one-three orders of magnitude advantage over an efficient gate-level combinational test pattern generator (that assumes full scan). In addition, the test application times obtained for our method are comparable with those of gate-level sequential test pattern generators, and up to two orders of magnitude smaller than designs using full scan . (37 Refs)

Subfile: B C

Descriptors: automatic testing; data flow graphs; design for testability; fault diagnosis; logic testing; sequential circuits

Identifiers: design-for-testability technique; register-transfer level circuits; control/data flow extraction; hierarchical testability; embedded element; precomputed test set; system primary inputs; symbolic justification; test multiplexers; symbolic controllability; symbolic observability; off-critical paths; protocol handlers; area/delay/power overheads; fault coverage; test generation times; sequential test

Class Codes: B1265B (Logic circuits); B0250 (Combinatorial mathematics); B7210B (Automatic test and measurement systems); C5210B (Computer-aided logic design); C1160 (Combinatorial mathematics); C7410D (Electronic engineering computing); C5120 (Logic and switching circuits)

Copyright 1998, IEE

17/5/3 (Item 1 from file: 95)
DIALOG(R)File: 95:TEME-Technology & Management
(c) 2005 FIZ TECHNIK. All rts. reserv.

01205075 E98050550212

Testing embedded memory array using unified scan path (Pruefen eingebetteter Speicher-Arrays unter Verwendung eines einheitlichen

Abtastpfades)
Yano, S
NEC Corp., J

NEC Research and Development, v39, n1, pp14-25, 1998 Document type: journal article Language: English

Record type: Abstract

ISSN: 0547-051X

ABSTRACT:

The authors have previously proposed a scannable memory configuration, which makes ordinary memory arrays to operate as virtual scan registers by adding a small support circuit. It allows incorporation of both memory arrays and flip-flops in a single scan path. Automatic test pattern generation for combinational circuits can thus be used to generate test pattern for sequential circuits composed of memory arrays and random logic. From the viewpoint of memory testing, this paper investigates the testability of the scannable memory configuration and proposes a memory array test using the scan path. Simply by comparing scan - in data and scan - out data, the test can detect memory specific faults such as coupling faults between memory cells as well as stuck-at faults. The test vector is 20 x m + s bit long, where m is the number of words of the memory array under test and s is the total scan path length.